SPANSION™ MCP

Data Sheet

September 2003

This document specifies SPANSION™ memory products that are now offered by both Advanced Micro Devices and Fujitsu. Although the document is marked with the name of the company that originally developed the specification, these products will be offered to customers of both AMD and Fujitsu.

Continuity of Specifications

There is no change to this datasheet as a result of offering the device as a SPANSION™ product. Future routine revisions will occur when appropriate, and changes will be noted in a revision summary.

Continuity of Ordering Part Numbers

AMD and Fujitsu continue to support existing part numbers beginning with "Am" and "MBM". To order these products, please use only the Ordering Part Numbers listed in this document.

For More Information

Please contact your local AMD or Fujitsu sales office for additional information about SPANSION™ memory solutions.

AMD

FUJITSU

FUJITSU SEMICONDUCTOR
DATA SHEET

DS05-50212-3E

Stacked MCP (Multi-Chip Package) FLASH MEMORY & FCRAM

CMOS

32M (×16) FLASH MEMORY & 16M (×16) SRAM Interface FCRAM

MB84VD22386EJ/VD22387EJ/VD22388EJ-85/90
MB84VD22396EJ/VD22397EJ/VD22398EJ-85/90

■ FEATURES

- **Power Supply Voltage of 2.7 V to 3.1 V for FCRAM**
- **Power Supply Voltage of 2.7 V to 3.3 V for Flash**
- **High Performance**
  85 ns maximum access time (Flash)
  85 ns maximum access time (FCRAM)
- **Operating Temperature**
  –30 °C to +85 °C
- **Package 71-ball BGA**

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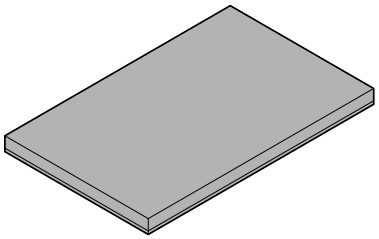
■ PRODUCT LINE-UP

	Flash Memory	FCRAM
Power Supply Voltage (V)	$V_{CC}f$* = 2.7 to 3.3	$V_{CC}s$* = 2.7 to 3.1
Max Address Access Time (ns)	85	85
Max $\overline{CE}$ Access Time (ns)	85	85
Max $\overline{OE}$ Access Time (ns)	35	50

*: Both $V_{CC}f$ and $V_{CC}s$ must be the same level when either part is being accessed.

■ PACKAGE

71-ball plastic BGA



(BGA-71P-M02)

Note : These guarantee both FCRAM and Flash at 85 ns Access Cycle.

FUJITSU

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1. FLASH MEMORY

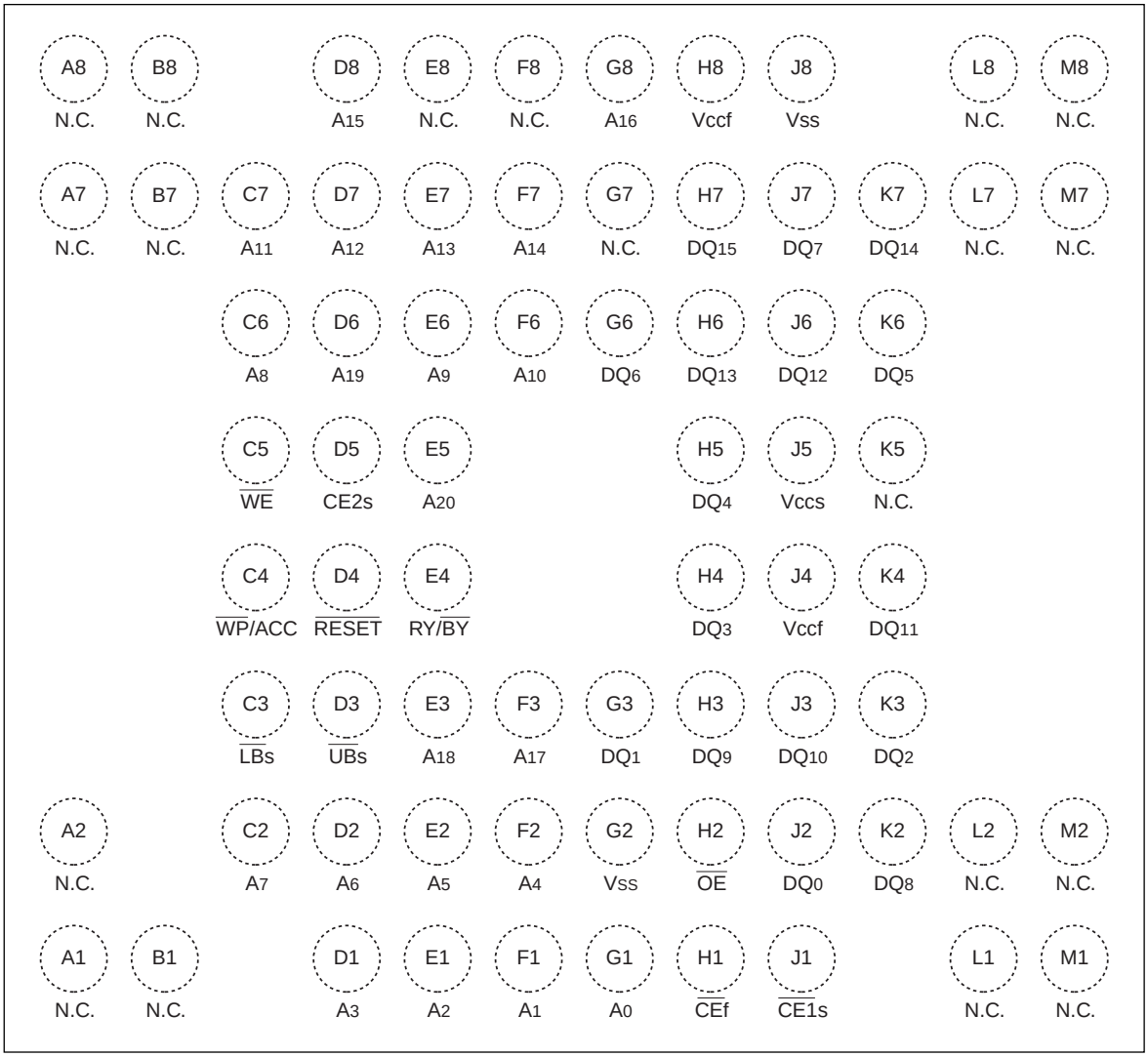
- **Simultaneous Read/Write Operations (Dual Bank)**
  Multiple devices available with different bank sizes
  Host system can program or erase in one bank, then immediately and simultaneously read from the other bank
  Zero latency between read and write operations
  Read-while-erase
  Read-while-program
- **Minimum 100,000 Write/Erase Cycles**
- **Sector Erase Architecture**
  Eight 4 K words and sixty three 32 K words.
  Any combination of sectors can be concurrently erased. The devices also support full chip erase.
- **Boot Code Sector Architecture**
  MB84VD22386EJ/VD22387EJ/VD22388EJ: Top sector
  MB84VD22396EJ/VD22397EJ/VD22398EJ: Bottom sector
- **Embedded Erase™ Algorithms**
  Automatically pre-programs and erases the chip or any sector
- **Embedded Program™ Algorithms**
  Automatically writes and verifies data at specified address
- **$\overline{\text{Data}}$ Polling and Toggle Bit Feature for Detection of Program or Erase Cycle Completion**
- **Ready-Busy Output (RY/$\overline{\text{BY}}$)**
  Hardware method for detection of program or erase cycle completion
- **Automatic Sleep Mode**
  When addresses remain stable, automatically switch themselves to low power mode.
- **Hidden ROM (Hi-ROM) Region**
  64 Kbyte of Hi-ROM, accessible through a new “Hi-ROM Enable” command sequence
  Factory serialized and protected to provide a secure electronic serial number (ESN)
- **$\overline{\text{WP}}$/ACC Input Pin**
  Allows protection of boot sectors at V_{IL}, regardless of sector protection/unprotection status
  (MB84VD22386EJ/VD22387EJ/VD22388EJ: SA69,SA70
  MB84VD22396EJ/VD22397EJ/VD22398EJ: SA0,SA1)
  Allows removal of boot sector protection at V_{IH}.
  At VACC, program time will reduce by 40%.
- **Erase Suspend/Resume**
  Suspends the erase operation to allow a read in another sector within the same device
- **Please Refer to “MBM29DL32XTE/BE” Data Sheet in Detailed Function**

2. FCRAM

- **Power Dissipation**
  Operating: 20 mA Max
  Standby: 70 µA Max
  Power Down: 10 µA Max
- **Power Down Control by CE2s**
- **Byte Write Control: $\overline{\text{LB}}$s (DQ_7-DQ_0), $\overline{\text{UB}}$s (DQ_{15}-DQ_5)**
- **4 Words Address Access Capability**

■ PIN ASSIGNMENT

(Top View)
Marking side

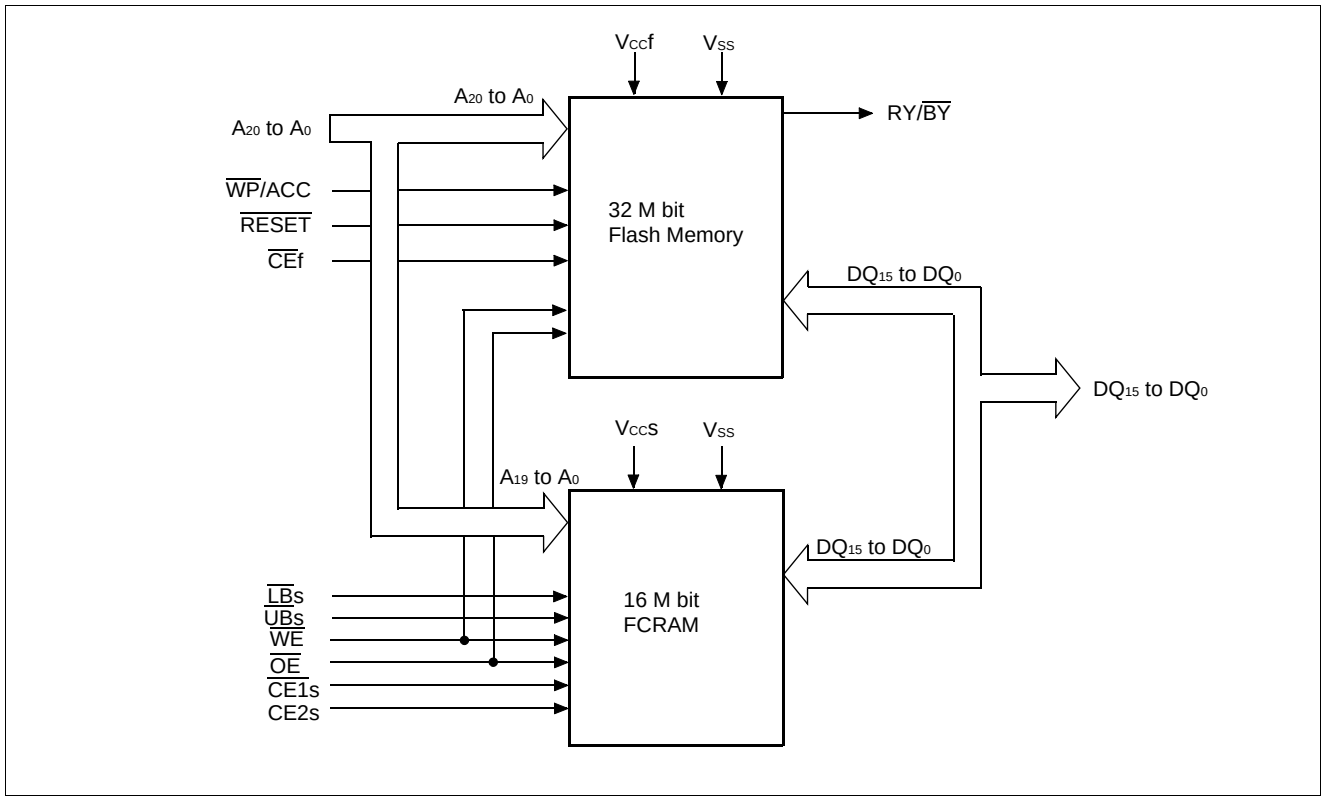


(BGA-71P-M02)

■ PIN DESCRIPTIONS

Pin Name	Input/Output	Function
A_{19} to A_0	I	Address Inputs (Common)
A_{20}	I	Address Input (Flash)
DQ_{15} to DQ_0	I/O	Data Inputs/Outputs (Common)
$\overline{CE}$f	I	Chip Enable (Flash)
$\overline{CE1}$s	I	Chip Enable (FCRAM)
CE2s	I	Chip Enable (FCRAM)
$\overline{OE}$	I	Output Enable (Common)
$\overline{WE}$	I	Write Enable (Common)
RY/$\overline{BY}$	O	Ready/Busy Outputs (Flash) Open Drain Output
$\overline{UB}$s	I	Upper Byte Control (FCRAM)
$\overline{LB}$s	I	Lower Byte Control (FCRAM)
$\overline{RESET}$	I	Hardware Reset Pin/Sector Protection Unlock (Flash)
$\overline{WP}$/ACC	I	Write Protect / Acceleration (Flash)
N.C.	—	No Internal Connection
V_{SS}	Power	Device Ground (Common)
V_{CC}f	Power	Device Power Supply (Flash)
V_{CC}s	Power	Device Power Supply (FCRAM)

■ BLOCK DIAGRAM



■ DEVICE BUS OPERATION

Operation *1, *2	$\overline{CE}$f	$\overline{CE1}$s	CE2s	$\overline{OE}$	$\overline{WE}$	$\overline{LB}$s	$\overline{UB}$s	DQ_7 to DQ_0	DQ_{15} to DQ_8	$\overline{RESET}$	$\overline{WP}$/ACC *7
Full Standby	H	H	H	X	X	X	X	High-Z	High-Z	H	X
Output Disable *3	H	L	H	H	H	X	X	High-Z	High-Z	H	X
	L	H	H	H	H	X	X	High-Z	High-Z		
Read from Flash *4	L	H	H	L	H	X	X	D_{OUT}	D_{OUT}	H	X
Write to Flash	L	H	H	H	L	X	X	D_{IN}	D_{IN}	H	X
Read from FCRAM *5	H	L	H	L	H	X	X	D_{OUT}	D_{OUT}	H	X
Write to FCRAM	H	L	H	H	L	L	L	D_{IN}	D_{IN}	H	X
						H	L	High-Z	D_{IN}		
						L	H	D_{IN}	High-Z		
Temporary Sector Group Unprotection *6	X	X	X	X	X	X	X	X	X	V_{ID}	X
Flash Hardware Reset	X	H	H	X	X	X	X	High-Z	High-Z	L	X
Boot Block Sector Write Protection	X	X	X	X	X	X	X	X	X	X	L
FCRAM Power Down *8	X	X	L	X	X	X	X	X	X	X	X

Legend: L = V_{IL}, H = V_{IH}, X = V_{IL} or V_{IH}. See "■ DC CHARACTERISTICS" for voltage levels.

*1: Other operations except for indicated this column are prohibited.

*2: Do not apply $\overline{CE}$f = V_{IL}, $\overline{CE1}$s = V_{IL} and CE2s = V_{IH} all at once.

*3: FCRAM Output Disable condition should not be kept longer than 1 μs.

*4: $\overline{WE}$ can be V_{IL} if $\overline{OE}$ is V_{IL}, $\overline{OE}$ at V_{IH} initiates the write operations.

*5: FCRAM Byte control at Read operation is not supported.

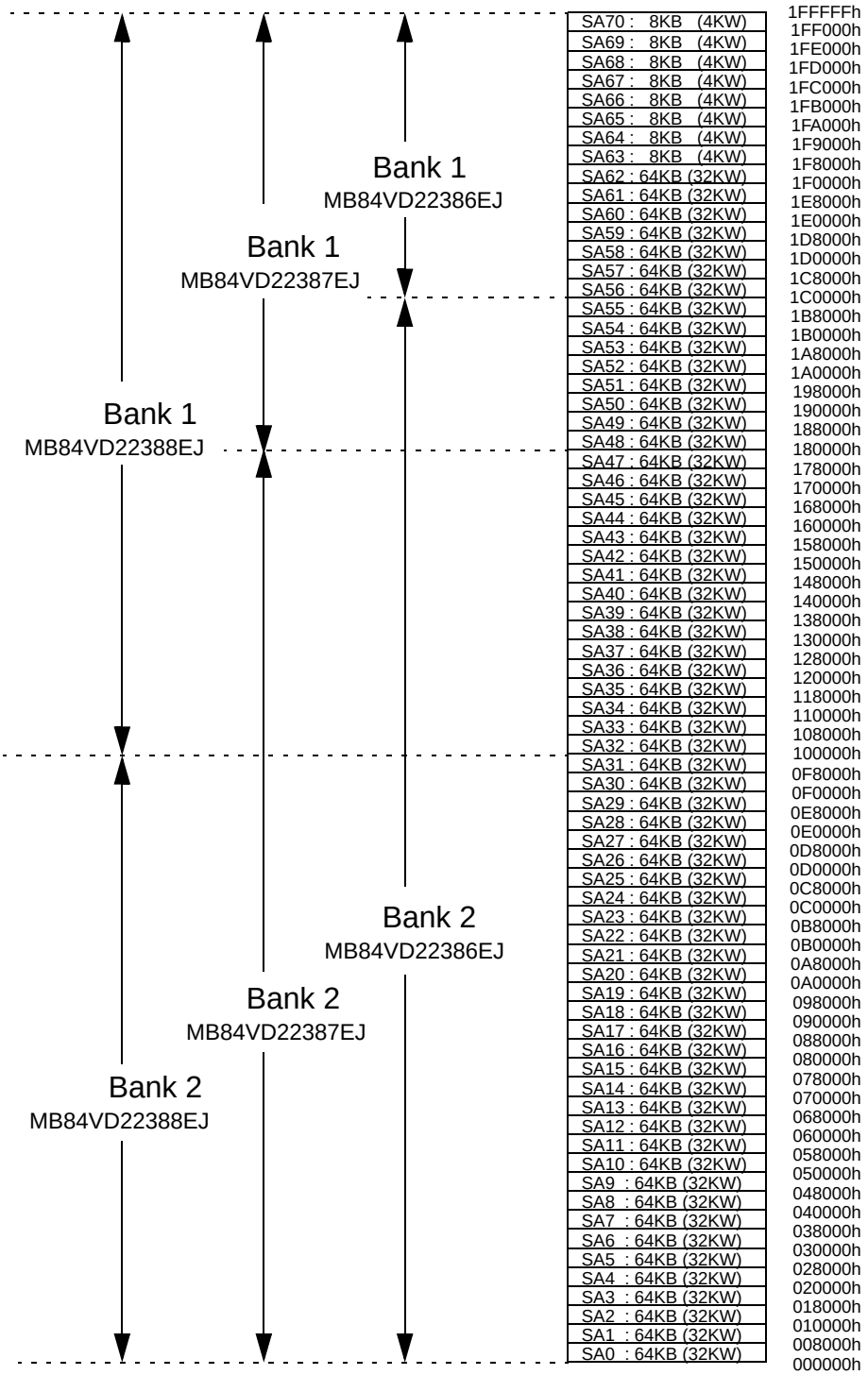
*6: Also used for the extended sector group protections.

*7: Protect "outermost" 2 × 8 Kbytes (4 words) on both ends of the boot block sectors.

*8: Power Down mode can be entered from Standby state and all DQ pins are in High-Z state.

■ FLEXIBLE SECTOR-ERASE ARCHITECTURE on FLASH MEMORY

- Eight 4 K words, and sixty three 32 K words.
- Individual-sector, multiple-sector, or bulk-erase capability.



MB84VD22386EJ/VD22387EJ/VD22388EJ Sector Architecture (Top Boot Block)

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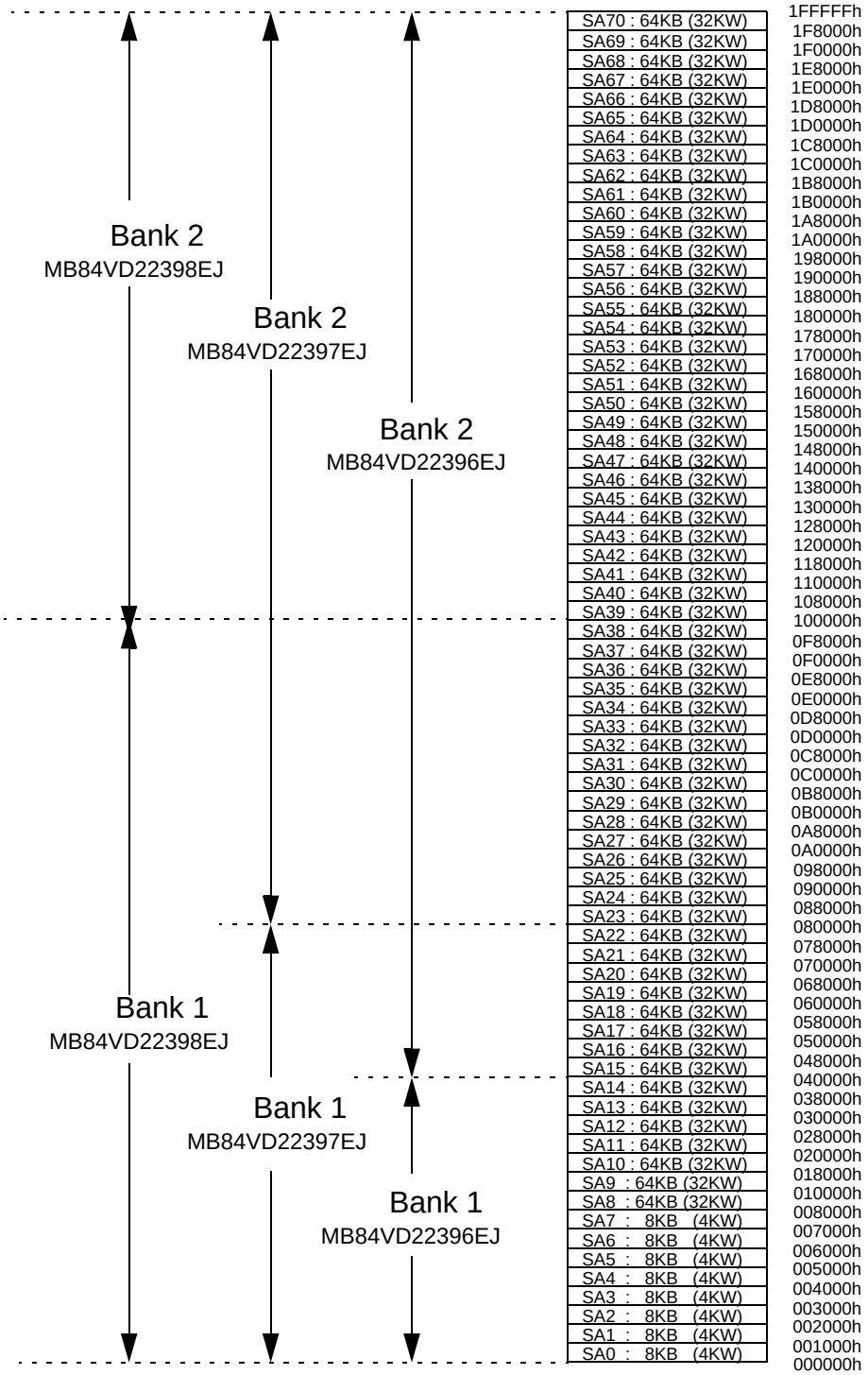

MB84VD22396EJ/VD22397EJ/VD22398EJ Sector Architecture (Bottom Boot Block)

Sector Address Tables (MB84VD22386EJ)

Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA0	0	0	0	0	0	0	X	X	X	X	000000h to 007FFFh
	SA1	0	0	0	0	0	1	X	X	X	X	008000h to 00FFFFh
	SA2	0	0	0	0	1	0	X	X	X	X	010000h to 017FFFh
	SA3	0	0	0	0	1	1	X	X	X	X	018000h to 01FFFFh
	SA4	0	0	0	1	0	0	X	X	X	X	020000h to 027FFFh
	SA5	0	0	0	1	0	1	X	X	X	X	028000h to 02FFFFh
	SA6	0	0	0	1	1	0	X	X	X	X	030000h to 037FFFh
	SA7	0	0	0	1	1	1	X	X	X	X	038000h to 03FFFFh
	SA8	0	0	1	0	0	0	X	X	X	X	040000h to 047FFFh
	SA9	0	0	1	0	0	1	X	X	X	X	048000h to 04FFFFh
	SA10	0	0	1	0	1	0	X	X	X	X	050000h to 057FFFh
	SA11	0	0	1	0	1	1	X	X	X	X	058000h to 05FFFFh
	SA12	0	0	1	1	0	0	X	X	X	X	060000h to 067FFFh
	SA13	0	0	1	1	0	1	X	X	X	X	068000h to 06FFFFh
	SA14	0	0	1	1	1	0	X	X	X	X	070000h to 077FFFh
	SA15	0	0	1	1	1	1	X	X	X	X	078000h to 07FFFFh
	SA16	0	1	0	0	0	0	X	X	X	X	080000h to 087FFFh
	SA17	0	1	0	0	0	1	X	X	X	X	088000h to 08FFFFh
	SA18	0	1	0	0	1	0	X	X	X	X	090000h to 097FFFh
	SA19	0	1	0	0	1	1	X	X	X	X	098000h to 09FFFFh
	SA20	0	1	0	1	0	0	X	X	X	X	0A0000h to 0A7FFFh
	SA21	0	1	0	1	0	1	X	X	X	X	0A8000h to 0AFFFFh
	SA22	0	1	0	1	1	0	X	X	X	X	0B0000h to 0B7FFFh
	SA23	0	1	0	1	1	1	X	X	X	X	0B8000h to 0BFFFFh
	SA24	0	1	1	0	0	0	X	X	X	X	0C0000h to 0C7FFFh
	SA25	0	1	1	0	0	1	X	X	X	X	0C8000h to 0CFFFFh
	SA26	0	1	1	0	1	0	X	X	X	X	0D0000h to 0D7FFFh
	SA27	0	1	1	0	1	1	X	X	X	X	0D8000h to 0DFFFFh
	SA28	0	1	1	1	0	0	X	X	X	X	0E0000h to 0E7FFFh
	SA29	0	1	1	1	0	1	X	X	X	X	0E8000h to 0EFFFFh
	SA30	0	1	1	1	1	0	X	X	X	X	0F0000h to 0F7FFFh
	SA31	0	1	1	1	1	1	X	X	X	X	0F8000h to 0FFFFFh
	SA32	1	0	0	0	0	0	X	X	X	X	100000h to 107FFFh
	SA33	1	0	0	0	0	1	X	X	X	X	108000h to 10FFFFh
	SA34	1	0	0	0	1	0	X	X	X	X	110000h to 117FFFh

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Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA35	1	0	0	0	1	1	X	X	X	X	118000h to 11FFFFh
	SA36	1	0	0	1	0	0	X	X	X	X	120000h to 127FFFh
	SA37	1	0	0	1	0	1	X	X	X	X	128000h to 12FFFFh
	SA38	1	0	0	1	1	0	X	X	X	X	130000h to 137FFFh
	SA39	1	0	0	1	1	1	X	X	X	X	138000h to 13FFFFh
	SA40	1	0	1	0	0	0	X	X	X	X	140000h to 147FFFh
	SA41	1	0	1	0	0	1	X	X	X	X	148000h to 14FFFFh
	SA42	1	0	1	0	1	0	X	X	X	X	150000h to 157FFFh
	SA43	1	0	1	0	1	1	X	X	X	X	158000h to 15FFFFh
	SA44	1	0	1	1	0	0	X	X	X	X	160000h to 167FFFh
	SA45	1	0	1	1	0	1	X	X	X	X	168000h to 16FFFFh
	SA46	1	0	1	1	1	0	X	X	X	X	170000h to 177FFFh
	SA47	1	0	1	1	1	1	X	X	X	X	178000h to 17FFFFh
	SA48	1	1	0	0	0	0	X	X	X	X	180000h to 187FFFh
	SA49	1	1	0	0	0	1	X	X	X	X	188000h to 18FFFFh
	SA50	1	1	0	0	1	0	X	X	X	X	190000h to 197FFFh
	SA51	1	1	0	0	1	1	X	X	X	X	198000h to 19FFFFh
	SA52	1	1	0	1	0	0	X	X	X	X	1A0000h to 1A7FFFh
	SA53	1	1	0	1	0	1	X	X	X	X	1A8000h to 1AFFFFh
	SA54	1	1	0	1	1	0	X	X	X	X	1B0000h to 1B7FFFh
	SA55	1	1	0	1	1	1	X	X	X	X	1B8000h to 1BFFFFh
Bank 1	SA56	1	1	1	0	0	0	X	X	X	X	1C0000h to 1C7FFFh
	SA57	1	1	1	0	0	1	X	X	X	X	1C8000h to 1CFFFFh
	SA58	1	1	1	0	1	0	X	X	X	X	1D0000h to 1D7FFFh
	SA59	1	1	1	0	1	1	X	X	X	X	1D8000h to 1DFFFFh
	SA60	1	1	1	1	0	0	X	X	X	X	1E0000h to 1E7FFFh
	SA61	1	1	1	1	0	1	X	X	X	X	1E8000h to 1EFFFFh
	SA62	1	1	1	1	1	0	X	X	X	X	1F0000h to 1F7FFFh
	SA63	1	1	1	1	1	1	0	0	0	X	1F8000h to 1F8FFFh
	SA64	1	1	1	1	1	1	0	0	1	X	1F9000h to 1F9FFFh
	SA65	1	1	1	1	1	1	0	1	0	X	1FA000h to 1FAFFFh
	SA66	1	1	1	1	1	1	0	1	1	X	1FB000h to 1FBFFFh
	SA67	1	1	1	1	1	1	1	0	0	X	1FC000h to 1FCFFFh
	SA68	1	1	1	1	1	1	1	0	1	X	1FD000h to 1FDFFFh
	SA69	1	1	1	1	1	1	1	1	0	X	1FE000h to 1FEFFFh
	SA70	1	1	1	1	1	1	1	1	1	X	1FF000h to 1FFFFFh

Sector Address Tables (MB84VD22396EJ)

Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 1	SA0	0	0	0	0	0	0	0	0	0	X	000000h to 000FFFh
	SA1	0	0	0	0	0	0	0	0	1	X	001000h to 001FFFh
	SA2	0	0	0	0	0	0	0	1	0	X	002000h to 002FFFh
	SA3	0	0	0	0	0	0	0	1	1	X	003000h to 003FFFh
	SA4	0	0	0	0	0	0	1	0	0	X	004000h to 004FFFh
	SA5	0	0	0	0	0	0	1	0	1	X	005000h to 005FFFh
	SA6	0	0	0	0	0	0	1	1	0	X	006000h to 006FFFh
	SA7	0	0	0	0	0	0	1	1	1	X	007000h to 007FFFh
	SA8	0	0	0	0	0	1	X	X	X	X	008000h to 00FFFFh
	SA9	0	0	0	0	1	0	X	X	X	X	010000h to 017FFFh
	SA10	0	0	0	0	1	1	X	X	X	X	018000h to 01FFFFh
	SA11	0	0	0	1	0	0	X	X	X	X	020000h to 027FFFh
	SA12	0	0	0	1	0	1	X	X	X	X	028000h to 02FFFFh
	SA13	0	0	0	1	1	0	X	X	X	X	030000h to 037FFFh
	SA14	0	0	0	1	1	1	X	X	X	X	038000h to 03FFFFh
Bank 2	SA15	0	0	1	0	0	0	X	X	X	X	040000h to 047FFFh
	SA16	0	0	1	0	0	1	X	X	X	X	048000h to 04FFFFh
	SA17	0	0	1	0	1	0	X	X	X	X	050000h to 057FFFh
	SA18	0	0	1	0	1	1	X	X	X	X	058000h to 05FFFFh
	SA19	0	0	1	1	0	0	X	X	X	X	060000h to 067FFFh
	SA20	0	0	1	1	0	1	X	X	X	X	068000h to 06FFFFh
	SA21	0	0	1	1	1	0	X	X	X	X	070000h to 077FFFh
	SA22	0	0	1	1	1	1	X	X	X	X	078000h to 07FFFFh
	SA23	0	1	0	0	0	0	X	X	X	X	080000h to 087FFFh
	SA24	0	1	0	0	0	1	X	X	X	X	088000h to 08FFFFh
	SA25	0	1	0	0	1	0	X	X	X	X	090000h to 097FFFh
	SA26	0	1	0	0	1	1	X	X	X	X	098000h to 09FFFFh
	SA27	0	1	0	1	0	0	X	X	X	X	0A0000h to 0A7FFFh
	SA28	0	1	0	1	0	1	X	X	X	X	0A8000h to 0AFFFFh
	SA29	0	1	0	1	1	0	X	X	X	X	0B0000h to 0B7FFFh
	SA30	0	1	0	1	1	1	X	X	X	X	0B8000h to 0BFFFFh
	SA31	0	1	1	0	0	0	X	X	X	X	0C0000h to 0C7FFFh
	SA32	0	1	1	0	0	1	X	X	X	X	0C8000h to 0CFFFFh
	SA33	0	1	1	0	1	0	X	X	X	X	0D0000h to 0D7FFFh
	SA34	0	1	1	0	1	1	X	X	X	X	0D8000h to 0DFFFFh
	SA35	0	1	1	1	0	0	X	X	X	X	0E0000h to 0E7FFFh
	SA36	0	1	1	1	0	1	X	X	X	X	0E8000h to 0EFFFFh
	SA37	0	1	1	1	1	0	X	X	X	X	0F0000h to 0F7FFFh
	SA38	0	1	1	1	1	1	X	X	X	X	0F8000h to 0FFFFFh

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Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA39	1	0	0	0	0	0	X	X	X	X	100000h to 107FFFh
	SA40	1	0	0	0	0	1	X	X	X	X	108000h to 10FFFFh
	SA41	1	0	0	0	1	0	X	X	X	X	110000h to 117FFFh
	SA42	1	0	0	0	1	1	X	X	X	X	118000h to 11FFFFh
	SA43	1	0	0	1	0	0	X	X	X	X	120000h to 127FFFh
	SA44	1	0	0	1	0	1	X	X	X	X	128000h to 12FFFFh
	SA45	1	0	0	1	1	0	X	X	X	X	130000h to 137FFFh
	SA46	1	0	0	1	1	1	X	X	X	X	138000h to 13FFFFh
	SA47	1	0	1	0	0	0	X	X	X	X	140000h to 147FFFh
	SA48	1	0	1	0	0	1	X	X	X	X	148000h to 14FFFFh
	SA49	1	0	1	0	1	0	X	X	X	X	150000h to 157FFFh
	SA50	1	0	1	0	1	1	X	X	X	X	158000h to 15FFFFh
	SA51	1	0	1	1	0	0	X	X	X	X	160000h to 167FFFh
	SA52	1	0	1	1	0	1	X	X	X	X	168000h to 16FFFFh
	SA53	1	0	1	1	1	0	X	X	X	X	170000h to 177FFFh
	SA54	1	0	1	1	1	1	X	X	X	X	178000h to 17FFFFh
	SA55	1	1	0	0	0	0	X	X	X	X	180000h to 187FFFh
	SA56	1	1	0	0	0	1	X	X	X	X	188000h to 18FFFFh
	SA57	1	1	0	0	1	0	X	X	X	X	190000h to 197FFFh
	SA58	1	1	0	0	1	1	X	X	X	X	198000h to 19FFFFh
	SA59	1	1	0	1	0	0	X	X	X	X	1A0000h to 1A7FFFh
	SA60	1	1	0	1	0	1	X	X	X	X	1A8000h to 1AFFFFh
	SA61	1	1	0	1	1	0	X	X	X	X	1B0000h to 1B7FFFh
	SA62	1	1	0	1	1	1	X	X	X	X	1B8000h to 1BFFFFh
	SA63	1	1	1	0	0	0	X	X	X	X	1C0000h to 1C7FFFh
	SA64	1	1	1	0	0	1	X	X	X	X	1C8000h to 1CFFFFh
	SA65	1	1	1	0	1	0	X	X	X	X	1D0000h to 1D7FFFh
	SA66	1	1	1	0	1	1	X	X	X	X	1D8000h to 1DFFFFh
	SA67	1	1	1	1	0	0	X	X	X	X	1E0000h to 1E7FFFh
	SA68	1	1	1	1	0	1	X	X	X	X	1E8000h to 1EFFFFh
	SA69	1	1	1	1	1	0	X	X	X	X	1F0000h to 1F7FFFh
	SA70	1	1	1	1	1	1	X	X	X	X	1F8000h to 1FFFFFh

Sector Address Tables (MB84VD22387EJ)

Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA0	0	0	0	0	0	0	X	X	X	X	000000h to 007FFFh
	SA1	0	0	0	0	0	1	X	X	X	X	008000h to 00FFFFh
	SA2	0	0	0	0	1	0	X	X	X	X	010000h to 017FFFh
	SA3	0	0	0	0	1	1	X	X	X	X	018000h to 01FFFFh
	SA4	0	0	0	1	0	0	X	X	X	X	020000h to 027FFFh
	SA5	0	0	0	1	0	1	X	X	X	X	028000h to 02FFFFh
	SA6	0	0	0	1	1	0	X	X	X	X	030000h to 037FFFh
	SA7	0	0	0	1	1	1	X	X	X	X	038000h to 03FFFFh
	SA8	0	0	1	0	0	0	X	X	X	X	040000h to 047FFFh
	SA9	0	0	1	0	0	1	X	X	X	X	048000h to 04FFFFh
	SA10	0	0	1	0	1	0	X	X	X	X	050000h to 057FFFh
	SA11	0	0	1	0	1	1	X	X	X	X	058000h to 05FFFFh
	SA12	0	0	1	1	0	0	X	X	X	X	060000h to 067FFFh
	SA13	0	0	1	1	0	1	X	X	X	X	068000h to 06FFFFh
	SA14	0	0	1	1	1	0	X	X	X	X	070000h to 077FFFh
	SA15	0	0	1	1	1	1	X	X	X	X	078000h to 07FFFFh
	SA16	0	1	0	0	0	0	X	X	X	X	080000h to 087FFFh
	SA17	0	1	0	0	0	1	X	X	X	X	088000h to 08FFFFh
	SA18	0	1	0	0	1	0	X	X	X	X	090000h to 097FFFh
	SA19	0	1	0	0	1	1	X	X	X	X	098000h to 09FFFFh
	SA20	0	1	0	1	0	0	X	X	X	X	0A0000h to 0A7FFFh
	SA21	0	1	0	1	0	1	X	X	X	X	0A8000h to 0AFFFFh
	SA22	0	1	0	1	1	0	X	X	X	X	0B0000h to 0B7FFFh
	SA23	0	1	0	1	1	1	X	X	X	X	0B8000h to 0BFFFFh
	SA24	0	1	1	0	0	0	X	X	X	X	0C0000h to 0C7FFFh
	SA25	0	1	1	0	0	1	X	X	X	X	0C8000h to 0CFFFFh
	SA26	0	1	1	0	1	0	X	X	X	X	0D0000h to 0D7FFFh
	SA27	0	1	1	0	1	1	X	X	X	X	0D8000h to 0DFFFFh
	SA28	0	1	1	1	0	0	X	X	X	X	0E0000h to 0E7FFFh
	SA29	0	1	1	1	0	1	X	X	X	X	0E8000h to 0EFFFFh
	SA30	0	1	1	1	1	0	X	X	X	X	0F0000h to 0F7FFFh
	SA31	0	1	1	1	1	1	X	X	X	X	0F8000h to 0FFFFFh

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Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA32	1	0	0	0	0	0	X	X	X	X	100000h to 107FFFh
	SA33	1	0	0	0	0	1	X	X	X	X	108000h to 10FFFFh
	SA34	1	0	0	0	1	0	X	X	X	X	110000h to 117FFFh
	SA35	1	0	0	0	1	1	X	X	X	X	118000h to 11FFFFh
	SA36	1	0	0	1	0	0	X	X	X	X	120000h to 127FFFh
	SA37	1	0	0	1	0	1	X	X	X	X	128000h to 12FFFFh
	SA38	1	0	0	1	1	0	X	X	X	X	130000h to 137FFFh
	SA39	1	0	0	1	1	1	X	X	X	X	138000h to 13FFFFh
	SA40	1	0	1	0	0	0	X	X	X	X	140000h to 147FFFh
	SA41	1	0	1	0	0	1	X	X	X	X	148000h to 14FFFFh
	SA42	1	0	1	0	1	0	X	X	X	X	150000h to 157FFFh
	SA43	1	0	1	0	1	1	X	X	X	X	158000h to 15FFFFh
	SA44	1	0	1	1	0	0	X	X	X	X	160000h to 167FFFh
	SA45	1	0	1	1	0	1	X	X	X	X	168000h to 16FFFFh
	SA46	1	0	1	1	1	0	X	X	X	X	170000h to 177FFFh
	SA47	1	0	1	1	1	1	X	X	X	X	178000h to 17FFFFh
Bank 1	SA48	1	1	0	0	0	0	X	X	X	X	180000h to 187FFFh
	SA49	1	1	0	0	0	1	X	X	X	X	188000h to 18FFFFh
	SA50	1	1	0	0	1	0	X	X	X	X	190000h to 197FFFh
	SA51	1	1	0	0	1	1	X	X	X	X	198000h to 19FFFFh
	SA52	1	1	0	1	0	0	X	X	X	X	1A0000h to 1A7FFFh
	SA53	1	1	0	1	0	1	X	X	X	X	1A8000h to 1AFFFFh
	SA54	1	1	0	1	1	0	X	X	X	X	1B0000h to 1B7FFFh
	SA55	1	1	0	1	1	1	X	X	X	X	1B8000h to 1BFFFFh
	SA56	1	1	1	0	0	0	X	X	X	X	1C0000h to 1C7FFFh
	SA57	1	1	1	0	0	1	X	X	X	X	1C8000h to 1CFFFFh
	SA58	1	1	1	0	1	0	X	X	X	X	1D0000h to 1D7FFFh
	SA59	1	1	1	0	1	1	X	X	X	X	1D8000h to 1DFFFFh
	SA60	1	1	1	1	0	0	X	X	X	X	1E0000h to 1E7FFFh
	SA61	1	1	1	1	0	1	X	X	X	X	1E8000h to 1EFFFFh
	SA62	1	1	1	1	1	0	X	X	X	X	1F0000h to 1F7FFFh
	SA63	1	1	1	1	1	1	0	0	0	X	1F8000h to 1F8FFFh
	SA64	1	1	1	1	1	1	0	0	1	X	1F9000h to 1F9FFFh
	SA65	1	1	1	1	1	1	0	1	0	X	1FA000h to 1FAFFFh
	SA66	1	1	1	1	1	1	0	1	1	X	1FB000h to 1FBFFFh
	SA67	1	1	1	1	1	1	1	0	0	X	1FC000h to 1FCFFFh
	SA68	1	1	1	1	1	1	1	0	1	X	1FD000h to 1FDFFFh
	SA69	1	1	1	1	1	1	1	1	0	X	1FE000h to 1FEFFFh
	SA70	1	1	1	1	1	1	1	1	1	X	1FF000h to 1FFFFFh

Sector Address Tables (MB84VD22397EJ)

Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 1	SA0	0	0	0	0	0	0	0	0	0	X	000000h to 000FFFh
	SA1	0	0	0	0	0	0	0	0	1	X	001000h to 001FFFh
	SA2	0	0	0	0	0	0	0	1	0	X	002000h to 002FFFh
	SA3	0	0	0	0	0	0	0	1	1	X	003000h to 003FFFh
	SA4	0	0	0	0	0	0	1	0	0	X	004000h to 004FFFh
	SA5	0	0	0	0	0	0	1	0	1	X	005000h to 005FFFh
	SA6	0	0	0	0	0	0	1	1	0	X	006000h to 006FFFh
	SA7	0	0	0	0	0	0	1	1	1	X	007000h to 007FFFh
	SA8	0	0	0	0	0	1	X	X	X	X	008000h to 00FFFFh
	SA9	0	0	0	0	1	0	X	X	X	X	010000h to 017FFFh
	SA10	0	0	0	0	1	1	X	X	X	X	018000h to 01FFFFh
	SA11	0	0	0	1	0	0	X	X	X	X	020000h to 027FFFh
	SA12	0	0	0	1	0	1	X	X	X	X	028000h to 02FFFFh
	SA13	0	0	0	1	1	0	X	X	X	X	030000h to 037FFFh
	SA14	0	0	0	1	1	1	X	X	X	X	038000h to 03FFFFh
	SA15	0	0	1	0	0	0	X	X	X	X	040000h to 047FFFh
	SA16	0	0	1	0	0	1	X	X	X	X	048000h to 04FFFFh
	SA17	0	0	1	0	1	0	X	X	X	X	050000h to 057FFFh
	SA18	0	0	1	0	1	1	X	X	X	X	058000h to 05FFFFh
	SA19	0	0	1	1	0	0	X	X	X	X	060000h to 067FFFh
	SA20	0	0	1	1	0	1	X	X	X	X	068000h to 06FFFFh
	SA21	0	0	1	1	1	0	X	X	X	X	070000h to 077FFFh
	SA22	0	0	1	1	1	1	X	X	X	X	078000h to 07FFFFh
Bank 2	SA23	0	1	0	0	0	0	X	X	X	X	080000h to 087FFFh
	SA24	0	1	0	0	0	1	X	X	X	X	088000h to 08FFFFh
	SA25	0	1	0	0	1	0	X	X	X	X	090000h to 097FFFh
	SA26	0	1	0	0	1	1	X	X	X	X	098000h to 09FFFFh
	SA27	0	1	0	1	0	0	X	X	X	X	0A0000h to 0A7FFFh
	SA28	0	1	0	1	0	1	X	X	X	X	0A8000h to 0AFFFFh
	SA29	0	1	0	1	1	0	X	X	X	X	0B0000h to 0B7FFFh
	SA30	0	1	0	1	1	1	X	X	X	X	0B8000h to 0BFFFFh
	SA31	0	1	1	0	0	0	X	X	X	X	0C0000h to 0C7FFFh
	SA32	0	1	1	0	0	1	X	X	X	X	0C8000h to 0CFFFFh
	SA33	0	1	1	0	1	0	X	X	X	X	0D0000h to 0D7FFFh
	SA34	0	1	1	0	1	1	X	X	X	X	0D8000h to 0DFFFFh
	SA35	0	1	1	1	0	0	X	X	X	X	0E0000h to 0E7FFFh
	SA36	0	1	1	1	0	1	X	X	X	X	0E8000h to 0EFFFFh
	SA37	0	1	1	1	1	0	X	X	X	X	0F0000h to 0F7FFFh
	SA38	0	1	1	1	1	1	X	X	X	X	0F8000h to 0FFFFFh

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Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA39	1	0	0	0	0	0	X	X	X	X	100000h to 107FFFh
	SA40	1	0	0	0	0	1	X	X	X	X	108000h to 10FFFFh
	SA41	1	0	0	0	1	0	X	X	X	X	110000h to 117FFFh
	SA42	1	0	0	0	1	1	X	X	X	X	118000h to 11FFFFh
	SA43	1	0	0	1	0	0	X	X	X	X	120000h to 127FFFh
	SA44	1	0	0	1	0	1	X	X	X	X	128000h to 12FFFFh
	SA45	1	0	0	1	1	0	X	X	X	X	130000h to 137FFFh
	SA46	1	0	0	1	1	1	X	X	X	X	138000h to 13FFFFh
	SA47	1	0	1	0	0	0	X	X	X	X	140000h to 147FFFh
	SA48	1	0	1	0	0	1	X	X	X	X	148000h to 14FFFFh
	SA49	1	0	1	0	1	0	X	X	X	X	150000h to 157FFFh
	SA50	1	0	1	0	1	1	X	X	X	X	158000h to 15FFFFh
	SA51	1	0	1	1	0	0	X	X	X	X	160000h to 167FFFh
	SA52	1	0	1	1	0	1	X	X	X	X	168000h to 16FFFFh
	SA53	1	0	1	1	1	0	X	X	X	X	170000h to 177FFFh
	SA54	1	0	1	1	1	1	X	X	X	X	178000h to 17FFFFh
	SA55	1	1	0	0	0	0	X	X	X	X	180000h to 187FFFh
	SA56	1	1	0	0	0	1	X	X	X	X	188000h to 18FFFFh
	SA57	1	1	0	0	1	0	X	X	X	X	190000h to 197FFFh
	SA58	1	1	0	0	1	1	X	X	X	X	198000h to 19FFFFh
	SA59	1	1	0	1	0	0	X	X	X	X	1A0000h to 1A7FFFh
	SA60	1	1	0	1	0	1	X	X	X	X	1A8000h to 1AFFFFh
	SA61	1	1	0	1	1	0	X	X	X	X	1B0000h to 1B7FFFh
	SA62	1	1	0	1	1	1	X	X	X	X	1B8000h to 1BFFFFh
	SA63	1	1	1	0	0	0	X	X	X	X	1C0000h to 1C7FFFh
	SA64	1	1	1	0	0	1	X	X	X	X	1C8000h to 1CFFFFh
	SA65	1	1	1	0	1	0	X	X	X	X	1D0000h to 1D7FFFh
	SA66	1	1	1	0	1	1	X	X	X	X	1D8000h to 1DFFFFh
	SA67	1	1	1	1	0	0	X	X	X	X	1E0000h to 1E7FFFh
	SA68	1	1	1	1	0	1	X	X	X	X	1E8000h to 1EFFFFh
	SA69	1	1	1	1	1	0	X	X	X	X	1F0000h to 1F7FFFh
	SA70	1	1	1	1	1	1	X	X	X	X	1F8000h to 1FFFFFh

Sector Address Tables (MB84VD22388EJ)

Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA0	0	0	0	0	0	0	X	X	X	X	000000h to 007FFFh
	SA1	0	0	0	0	0	1	X	X	X	X	008000h to 00FFFFh
	SA2	0	0	0	0	1	0	X	X	X	X	010000h to 017FFFh
	SA3	0	0	0	0	1	1	X	X	X	X	018000h to 01FFFFh
	SA4	0	0	0	1	0	0	X	X	X	X	020000h to 027FFFh
	SA5	0	0	0	1	0	1	X	X	X	X	028000h to 02FFFFh
	SA6	0	0	0	1	1	0	X	X	X	X	030000h to 037FFFh
	SA7	0	0	0	1	1	1	X	X	X	X	038000h to 03FFFFh
	SA8	0	0	1	0	0	0	X	X	X	X	040000h to 047FFFh
	SA9	0	0	1	0	0	1	X	X	X	X	048000h to 04FFFFh
	SA10	0	0	1	0	1	0	X	X	X	X	050000h to 057FFFh
	SA11	0	0	1	0	1	1	X	X	X	X	058000h to 05FFFFh
	SA12	0	0	1	1	0	0	X	X	X	X	060000h to 067FFFh
	SA13	0	0	1	1	0	1	X	X	X	X	068000h to 06FFFFh
	SA14	0	0	1	1	1	0	X	X	X	X	070000h to 077FFFh
	SA15	0	0	1	1	1	1	X	X	X	X	078000h to 07FFFFh
	SA16	0	1	0	0	0	0	X	X	X	X	080000h to 087FFFh
	SA17	0	1	0	0	0	1	X	X	X	X	088000h to 08FFFFh
	SA18	0	1	0	0	1	0	X	X	X	X	090000h to 097FFFh
	SA19	0	1	0	0	1	1	X	X	X	X	098000h to 09FFFFh
	SA20	0	1	0	1	0	0	X	X	X	X	0A0000h to 0A7FFFh
	SA21	0	1	0	1	0	1	X	X	X	X	0A8000h to 0AFFFFh
	SA22	0	1	0	1	1	0	X	X	X	X	0B0000h to 0B7FFFh
	SA23	0	1	0	1	1	1	X	X	X	X	0B8000h to 0BFFFFh
	SA24	0	1	1	0	0	0	X	X	X	X	0C0000h to 0C7FFFh
	SA25	0	1	1	0	0	1	X	X	X	X	0C8000h to 0CFFFFh
	SA26	0	1	1	0	1	0	X	X	X	X	0D0000h to 0D7FFFh
	SA27	0	1	1	0	1	1	X	X	X	X	0D8000h to 0DFFFFh
	SA28	0	1	1	1	0	0	X	X	X	X	0E0000h to 0E7FFFh
	SA29	0	1	1	1	0	1	X	X	X	X	0E8000h to 0EFFFFh
	SA30	0	1	1	1	1	0	X	X	X	X	0F0000h to 0F7FFFh
	SA31	0	1	1	1	1	1	X	X	X	X	0F8000h to 0FFFFFh

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Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 1	SA32	1	0	0	0	0	0	X	X	X	X	100000h to 107FFFh
	SA33	1	0	0	0	0	1	X	X	X	X	108000h to 10FFFFh
	SA34	1	0	0	0	1	0	X	X	X	X	110000h to 117FFFh
	SA35	1	0	0	0	1	1	X	X	X	X	118000h to 11FFFFh
	SA36	1	0	0	1	0	0	X	X	X	X	120000h to 127FFFh
	SA37	1	0	0	1	0	1	X	X	X	X	128000h to 12FFFFh
	SA38	1	0	0	1	1	0	X	X	X	X	130000h to 137FFFh
	SA39	1	0	0	1	1	1	X	X	X	X	138000h to 13FFFFh
	SA40	1	0	1	0	0	0	X	X	X	X	140000h to 147FFFh
	SA41	1	0	1	0	0	1	X	X	X	X	148000h to 14FFFFh
	SA42	1	0	1	0	1	0	X	X	X	X	150000h to 157FFFh
	SA43	1	0	1	0	1	1	X	X	X	X	158000h to 15FFFFh
	SA44	1	0	1	1	0	0	X	X	X	X	160000h to 167FFFh
	SA45	1	0	1	1	0	1	X	X	X	X	168000h to 16FFFFh
	SA46	1	0	1	1	1	0	X	X	X	X	170000h to 177FFFh
	SA47	1	0	1	1	1	1	X	X	X	X	178000h to 17FFFFh
	SA48	1	1	0	0	0	0	X	X	X	X	180000h to 187FFFh
	SA49	1	1	0	0	0	1	X	X	X	X	188000h to 18FFFFh
	SA50	1	1	0	0	1	0	X	X	X	X	190000h to 197FFFh
	SA51	1	1	0	0	1	1	X	X	X	X	198000h to 19FFFFh
	SA52	1	1	0	1	0	0	X	X	X	X	1A0000h to 1A7FFFh
	SA53	1	1	0	1	0	1	X	X	X	X	1A8000h to 1AFFFFh
	SA54	1	1	0	1	1	0	X	X	X	X	1B0000h to 1B7FFFh
	SA55	1	1	0	1	1	1	X	X	X	X	1B8000h to 1BFFFFh
	SA56	1	1	1	0	0	0	X	X	X	X	1C0000h to 1C7FFFh
	SA57	1	1	1	0	0	1	X	X	X	X	1C8000h to 1CFFFFh
	SA58	1	1	1	0	1	0	X	X	X	X	1D0000h to 1D7FFFh
	SA59	1	1	1	0	1	1	X	X	X	X	1D8000h to 1DFFFFh
	SA60	1	1	1	1	0	0	X	X	X	X	1E0000h to 1E7FFFh
	SA61	1	1	1	1	0	1	X	X	X	X	1E8000h to 1EFFFFh
	SA62	1	1	1	1	1	0	X	X	X	X	1F0000h to 1F7FFFh
	SA63	1	1	1	1	1	1	0	0	0	X	1F8000h to 1F8FFFh
	SA64	1	1	1	1	1	1	0	0	1	X	1F9000h to 1F9FFFh
	SA65	1	1	1	1	1	1	0	1	0	X	1FA000h to 1FAFFFh
	SA66	1	1	1	1	1	1	0	1	1	X	1FB000h to 1FBFFFh
	SA67	1	1	1	1	1	1	1	0	0	X	1FC000h to 1FCFFFh
	SA68	1	1	1	1	1	1	1	0	1	X	1FD000h to 1FDFFFh
	SA69	1	1	1	1	1	1	1	1	0	X	1FE000h to 1FEFFFh
	SA70	1	1	1	1	1	1	1	1	1	X	1FF000h to 1FFFFFh

Sector Address Tables (MB84VD22398EJ)

Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 1	SA0	0	0	0	0	0	0	0	0	0	X	000000h to 000FFFh
	SA1	0	0	0	0	0	0	0	0	1	X	001000h to 001FFFh
	SA2	0	0	0	0	0	0	0	1	0	X	002000h to 002FFFh
	SA3	0	0	0	0	0	0	0	1	1	X	003000h to 003FFFh
	SA4	0	0	0	0	0	0	1	0	0	X	004000h to 004FFFh
	SA5	0	0	0	0	0	0	1	0	1	X	005000h to 005FFFh
	SA6	0	0	0	0	0	0	1	1	0	X	006000h to 006FFFh
	SA7	0	0	0	0	0	0	1	1	1	X	007000h to 007FFFh
	SA8	0	0	0	0	0	1	X	X	X	X	008000h to 00FFFFh
	SA9	0	0	0	0	1	0	X	X	X	X	010000h to 017FFFh
	SA10	0	0	0	0	1	1	X	X	X	X	018000h to 01FFFFh
	SA11	0	0	0	1	0	0	X	X	X	X	020000h to 027FFFh
	SA12	0	0	0	1	0	1	X	X	X	X	028000h to 02FFFFh
	SA13	0	0	0	1	1	0	X	X	X	X	030000h to 037FFFh
	SA14	0	0	0	1	1	1	X	X	X	X	038000h to 03FFFFh
	SA15	0	0	1	0	0	0	X	X	X	X	040000h to 047FFFh
	SA16	0	0	1	0	0	1	X	X	X	X	048000h to 04FFFFh
	SA17	0	0	1	0	1	0	X	X	X	X	050000h to 057FFFh
	SA18	0	0	1	0	1	1	X	X	X	X	058000h to 05FFFFh
	SA19	0	0	1	1	0	0	X	X	X	X	060000h to 067FFFh
	SA20	0	0	1	1	0	1	X	X	X	X	068000h to 06FFFFh
	SA21	0	0	1	1	1	0	X	X	X	X	070000h to 077FFFh
	SA22	0	0	1	1	1	1	X	X	X	X	078000h to 07FFFFh
	SA23	0	1	0	0	0	0	X	X	X	X	080000h to 087FFFh
	SA24	0	1	0	0	0	1	X	X	X	X	088000h to 08FFFFh
	SA25	0	1	0	0	1	0	X	X	X	X	090000h to 097FFFh
	SA26	0	1	0	0	1	1	X	X	X	X	098000h to 09FFFFh
	SA27	0	1	0	1	0	0	X	X	X	X	0A0000h to 0A7FFFh
	SA28	0	1	0	1	0	1	X	X	X	X	0A8000h to 0AFFFFh
	SA29	0	1	0	1	1	0	X	X	X	X	0B0000h to 0B7FFFh
	SA30	0	1	0	1	1	1	X	X	X	X	0B8000h to 0BFFFFh
	SA31	0	1	1	0	0	0	X	X	X	X	0C0000h to 0C7FFFh
	SA32	0	1	1	0	0	1	X	X	X	X	0C8000h to 0CFFFFh
	SA33	0	1	1	0	1	0	X	X	X	X	0D0000h to 0D7FFFh
	SA34	0	1	1	0	1	1	X	X	X	X	0D8000h to 0DFFFFh
	SA35	0	1	1	1	0	0	X	X	X	X	0E0000h to 0E7FFFh
	SA36	0	1	1	1	0	1	X	X	X	X	0E8000h to 0EFFFFh
	SA37	0	1	1	1	1	0	X	X	X	X	0F0000h to 0F7FFFh
	SA38	0	1	1	1	1	1	X	X	X	X	0F8000h to 0FFFFFh

(Continued)

(Continued)

Bank	Sector	Sector Address										Address Range
		Bank Address										
		A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	
Bank 2	SA39	1	0	0	0	0	0	X	X	X	X	100000h to 107FFFh
	SA40	1	0	0	0	0	1	X	X	X	X	108000h to 10FFFFh
	SA41	1	0	0	0	1	0	X	X	X	X	110000h to 117FFFh
	SA42	1	0	0	0	1	1	X	X	X	X	118000h to 11FFFFh
	SA43	1	0	0	1	0	0	X	X	X	X	120000h to 127FFFh
	SA44	1	0	0	1	0	1	X	X	X	X	128000h to 12FFFFh
	SA45	1	0	0	1	1	0	X	X	X	X	130000h to 137FFFh
	SA46	1	0	0	1	1	1	X	X	X	X	138000h to 13FFFFh
	SA47	1	0	1	0	0	0	X	X	X	X	140000h to 147FFFh
	SA48	1	0	1	0	0	1	X	X	X	X	148000h to 14FFFFh
	SA49	1	0	1	0	1	0	X	X	X	X	150000h to 157FFFh
	SA50	1	0	1	0	1	1	X	X	X	X	158000h to 15FFFFh
	SA51	1	0	1	1	0	0	X	X	X	X	160000h to 167FFFh
	SA52	1	0	1	1	0	1	X	X	X	X	168000h to 16FFFFh
	SA53	1	0	1	1	1	0	X	X	X	X	170000h to 177FFFh
	SA54	1	0	1	1	1	1	X	X	X	X	178000h to 17FFFFh
	SA55	1	1	0	0	0	0	X	X	X	X	180000h to 187FFFh
	SA56	1	1	0	0	0	1	X	X	X	X	188000h to 18FFFFh
	SA57	1	1	0	0	1	0	X	X	X	X	190000h to 197FFFh
	SA58	1	1	0	0	1	1	X	X	X	X	198000h to 19FFFFh
	SA59	1	1	0	1	0	0	X	X	X	X	1A0000h to 1A7FFFh
	SA60	1	1	0	1	0	1	X	X	X	X	1A8000h to 1AFFFFh
	SA61	1	1	0	1	1	0	X	X	X	X	1B0000h to 1B7FFFh
	SA62	1	1	0	1	1	1	X	X	X	X	1B8000h to 1BFFFFh
	SA63	1	1	1	0	0	0	X	X	X	X	1C0000h to 1C7FFFh
	SA64	1	1	1	0	0	1	X	X	X	X	1C8000h to 1CFFFFh
	SA65	1	1	1	0	1	0	X	X	X	X	1D0000h to 1D7FFFh
	SA66	1	1	1	0	1	1	X	X	X	X	1D8000h to 1DFFFFh
	SA67	1	1	1	1	0	0	X	X	X	X	1E0000h to 1E7FFFh
	SA68	1	1	1	1	0	1	X	X	X	X	1E8000h to 1EFFFFh
	SA69	1	1	1	1	1	0	X	X	X	X	1F0000h to 1F7FFFh
	SA70	1	1	1	1	1	1	X	X	X	X	1F8000h to 1FFFFFh

Sector Group Addresses (MB84VD22386EJ/VD22387EJ/VD22388EJ)
(Top Boot Block)

Sector Group	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	Sectors
SGA0	0	0	0	0	0	0	X	X	X	SA0
SGA1	0	0	0	0	0	1	X	X	X	SA1 to SA3
					1	0				
					1	1				
SGA2	0	0	0	1	X	X	X	X	X	SA4 to SA7
SGA3	0	0	1	0	X	X	X	X	X	SA8 to SA11
SGA4	0	0	1	1	X	X	X	X	X	SA12 to SA15
SGA5	0	1	0	0	X	X	X	X	X	SA16 to SA19
SGA6	0	1	0	1	X	X	X	X	X	SA20 to SA23
SGA7	0	1	1	0	X	X	X	X	X	SA24 to SA27
SGA8	0	1	1	1	X	X	X	X	X	SA28 to SA31
SGA9	1	0	0	0	X	X	X	X	X	SA32 to SA35
SGA10	1	0	0	1	X	X	X	X	X	SA36 to SA39
SGA11	1	0	1	0	X	X	X	X	X	SA40 to SA43
SGA12	1	0	1	1	X	X	X	X	X	SA44 to SA47
SGA13	1	1	0	0	X	X	X	X	X	SA48 to SA51
SGA14	1	1	0	1	X	X	X	X	X	SA52 to SA55
SGA15	1	1	1	0	X	X	X	X	X	SA56 to SA59
SGA16	1	1	1	1	0	0	X	X	X	SA60 to SA62
					0	1				
					1	0				
SGA17	1	1	1	1	1	1	0	0	0	SA63
SGA18	1	1	1	1	1	1	0	0	1	SA64
SGA19	1	1	1	1	1	1	0	1	0	SA65
SGA20	1	1	1	1	1	1	0	1	1	SA66
SGA21	1	1	1	1	1	1	1	0	0	SA67
SGA22	1	1	1	1	1	1	1	0	1	SA68
SGA23	1	1	1	1	1	1	1	1	0	SA69
SGA24	1	1	1	1	1	1	1	1	1	SA70

Sector Group Addresses (MB84VD22396EJ/VD22397EJ/VD22398EJ)
(Bottom Boot Block)

Sector Group	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	Sectors
SGA0	0	0	0	0	0	0	0	0	0	SA0
SGA1	0	0	0	0	0	0	0	0	1	SA1
SGA2	0	0	0	0	0	0	0	1	0	SA2
SGA3	0	0	0	0	0	0	0	1	1	SA3
SGA4	0	0	0	0	0	0	1	0	0	SA4
SGA5	0	0	0	0	0	0	1	0	1	SA5
SGA6	0	0	0	0	0	0	1	1	0	SA6
SGA7	0	0	0	0	0	0	1	1	1	SA7
SGA8	0	0	0	0	0	1	X	X	X	SA8 to SA10
					1	0				
					1	1				
SGA9	0	0	0	1	X	X	X	X	X	SA11 to SA14
SGA10	0	0	1	0	X	X	X	X	X	SA15 to SA18
SGA11	0	0	1	1	X	X	X	X	X	SA19 to SA22
SGA12	0	1	0	0	X	X	X	X	X	SA23 to SA26
SGA13	0	1	0	1	X	X	X	X	X	SA27 to SA30
SGA14	0	1	1	0	X	X	X	X	X	SA31 to SA34
SGA15	0	1	1	1	X	X	X	X	X	SA35 to SA38
SGA16	1	0	0	0	X	X	X	X	X	SA39 to SA42
SGA17	1	0	0	1	X	X	X	X	X	SA43 to SA46
SGA18	1	0	1	0	X	X	X	X	X	SA47 to SA50
SGA19	1	0	1	1	X	X	X	X	X	SA51 to SA54
SGA20	1	1	0	0	X	X	X	X	X	SA55 to SA58
SGA21	1	1	0	1	X	X	X	X	X	SA59 to SA62
SGA22	1	1	1	0	X	X	X	X	X	SA63 to SA66
SGA23	1	1	1	1	0	0	X	X	X	SA67 to SA69
					0	1				
					1	0				
SGA24	1	1	1	1	1	1	X	X	X	SA70

Flash Memory Autoselect Codes

Type		A_{19} to A_{12}	A_6	A_1	A_0	Code (HEX)
Manufacturer's Code		BA	V_{IL}	V_{IL}	V_{IL}	04h
Device Code	MB84VD22386EJ	BA	V_{IL}	V_{IL}	V_{IH}	2255h
	MB84VD22396EJ	BA	V_{IL}	V_{IL}	V_{IH}	2256h
	MB84VD22387EJ	BA	V_{IL}	V_{IL}	V_{IH}	2250h
	MB84VD22397EJ	BA	V_{IL}	V_{IL}	V_{IH}	2253h
	MB84VD22388EJ	BA	V_{IL}	V_{IL}	V_{IH}	225Ch
	MB84VD22398EJ	BA	V_{IL}	V_{IL}	V_{IH}	225Fh
Sector Group protect		Sector Group Address	V_{IL}	V_{IH}	V_{IL}	01h *

*: Output 01h at protected sector address and output 00h at unprotected sector address.

Flash Memory Command Definitions

Command Sequence	Bus Write Cycles Req'd	First Bus Write Cycle		Second Bus Write Cycle		Third Bus Write Cycle		Fourth Bus Read/Write Cycle		Fifth Bus Write Cycle		Sixth Bus Write Cycle	
		Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data
Read/Reset *1	1	XXXh	F0h	—	—	—	—	—	—	—	—	—	—
Read/Reset *1	3	555h	AAh	2AAh	55h	555h	F0h	RA	RD	—	—	—	—
Autoselect	3	555h	AAh	2AAh	55h	(BA) 555h	90h	—	—	—	—	—	—
Program	4	555h	AAh	2AAh	55h	555h	A0h	PA	PD	—	—	—	—
Chip Erase	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	555h	10h
Sector Erase	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	SA	30h
Sector Erase Suspend	1	BA	B0h	—	—	—	—	—	—	—	—	—	—
Sector Erase Resume	1	BA	30h	—	—	—	—	—	—	—	—	—	—
Program Suspend	1	BA	B0h	—	—	—	—	—	—	—	—	—	—
Program Resume	1	BA	30h	—	—	—	—	—	—	—	—	—	—
Set to Fast Mode	3	555h	AAh	2AAh	55h	555h	20h	—	—	—	—	—	—
Fast Program *2	2	XXXh	A0h	PA	PD	—	—	—	—	—	—	—	—
Reset from Fast Mode *2	2	BA	90h	XXXh	F0h*6	—	—	—	—	—	—	—	—
Extended Sector Group Protection *3	4	XXXh	60h	SPA	60h	SPA	40h	SPA	SD	—	—	—	—
Query *4	1	55h	98h	—	—	—	—	—	—	—	—	—	—
Hi-ROM Entry	3	555h	AAh	2AAh	55h	555h	88h	—	—	—	—	—	—
Hi-ROM Program *5	4	555h	AAh	2AAh	55h	555h	A0h	PA	PD	—	—	—	—
Hi-ROM Erase *5	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	HRA	30h
Hi-ROM Exit *5	4	555h	AAh	2AAh	55h	(HRBA) 555h	90h	XXXh	00h	—	—	—	—

*1: Both Read/Reset commands are functionally equivalent, resetting the device to the read mode.

*2: This command is valid during Fast Mode.

*3: This command is valid while $\overline{RESET}=V_{ID}$.

*4: The valid Address is A_6 to A_0.

*5: This command is valid during Hi-ROM mode.

*6: The data "00h" is also acceptable.

Notes: Address bits A_{20} to A_{11} = X = "H" or "L" for all address commands except for Program Address (PA), Sector Address (SA), and Bank Address (BA).
Bus operations are defined in "■ DEVICE BUS OPERATION".
RA = Address of the memory location to be read.
PA = Address of the memory location to be programmed.
Addresses are latched on the falling edge of the write pulse.
SA = Address of the sector to be erased. The combination of A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12} will uniquely select any sector.
BA = Bank address (A_{20} to A_{15})
SPA = Sector group address to be protected. Set sector group address (SPA) and (A_6, A_1, A_0) = (0, 1, 0).

HRA= Address of the Hidden-ROM area.
MB84VD22386EJ/VD22387EJ/VD22388EJ (Top Boot Type)
Word mode: 1F8000h to 1FFFFFh
Byte mode: 3F0000h to 3FFFFFh
MB84VD22396EJ/VD22397EJ/VD22398EJ (Bottom Boot Type)
Word mode: 000000h to 007FFFh
Byte mode: 000000h to 00FFFFh
HRBA = Bank address of the Hidden-ROM area
MB84VD22386EJ/VD22387EJ/VD22388EJ (Top Boot Type)
$A_{20} = A_{19} = A_{18} = A_{17} = A_{16} = A_{15} = 1$
MB84VD22396EJ/VD22397EJ/VD22398EJ (Bottom Boot Type)
$A_{20} = A_{19} = A_{18} = A_{17} = A_{16} = A_{15} = 0$
RD = Data read from location RA during read operation.
PD = Data to be programmed at location PA.
SD = Sector protection verify data. Output 01h at protected sector addresses and output 00h at unprotected sector addresses.

The system should generate the following address patterns: 555h or 2AAh to addresses A_{10} to A_0

■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating		Unit
		Min	Max	
Storage Temperature	Tstg	–55	+125	°C
Ambient Temperature with Power Applied	T_A	–30	+85	°C
Voltage with Respect to Ground All pins *1	V_{IN}, V_{OUT}	–0.3	$V_{CC}f$ +0.3	V
			$V_{CC}s$ +0.3	V
$V_{CC}f$ Supply *1	$V_{CC}f$	–0.2	+3.6	V
$V_{CC}s$ Supply *1	$V_{CC}s$	–0.2	+3.3	V
$\overline{RESET}$ *2	V_{IN}	–0.5	+13.0	V
$\overline{WP}$/ACC *3	V_{IN}	–0.5	+10.5	V

*1: Minimum DC voltage on input or I/O pins is –0.3 V. During voltage transitions, input or I/O pins may undershoot V_{SS} to –1.0 V for periods of up to 20 ns. Maximum DC voltage on input or I/O pins is $V_{CC}f$ + 0.3 V or $V_{CC}s$ + 0.3 V. During voltage transitions, input or I/O pins may overshoot to $V_{CC}f$ + 1.0 V or $V_{CC}s$ + 1.0 V for periods of up to 5 ns.

*2: Minimum DC input voltage on $\overline{RESET}$ pin is –0.5 V. During voltage transitions, $\overline{RESET}$ pin may undershoot V_{SS} to –2.0 V for periods of up to 20 ns.
Voltage difference between input and supply voltage (VIN-$V_{CC}f$ or $V_{CC}s$) does not exceed 9.0 V.
Maximum DC input voltage on $\overline{RESET}$ pin is +13.0 V which may overshoot to +14.0 V for periods of up to 20 ns.

*3: Minimum DC input voltage on $\overline{WP}$/ACC pin is –0.5 V. During voltage transitions, $\overline{WP}$/ACC pin may undershoot Vss to –2.0 V for periods of up to 20 ns. Maximum DC input voltage on $\overline{WP}$/ACC pin is +10.5 V which may overshoot to +10.5 V for periods of up to 20 ns, when $V_{CC}f$ is applied.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Value		Unit
		Min	Max	
Ambient Temperature	T_A	–30	+85	°C
$V_{CC}f$ Supply Voltage	$V_{CC}f$	+2.7	+3.3	V
$V_{CC}s$ Supply Voltage	$V_{CC}s$	+2.7	+3.1	V

Note: Operating ranges define those limits between which the functionality of the device is guaranteed.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ DC CHARACTERISTICS

Parameter	Sym-bol	Conditions		Value			Unit
				Min	Typ	Max	
Input Leakage Current	I_{LI}	V_{IN} = V_{SS} to V_{CC}		–1.0	—	+1.0	µA
Output Leakage Current	I_{LO}	V_{OUT} = V_{SS} to V_{CC}		–1.0	—	+1.0	µA
$\overline{RESET}$ Inputs Leakage Current	I_{LIT}	V_{CC} = V_{CC} Max, $\overline{RESET}$ = 12.5 V		—	—	35	µA
ACC Input Leakage Current	I_{LIA}	V_{CC} = V_{CC} Max, $\overline{WP}$/ACC = V_{ACC} Max		—	—	20	mA
Flash V_{CC} Active Current (Read) *1	$I_{CC1}f$	$\overline{CE}f$ = V_{IL}, $\overline{OE}$ = V_{IH}	t_{CYCLE} = 5 MHz	—	—	18	mA
			t_{CYCLE} = 1 MHz	—	—	7	mA
Flash V_{CC} Active Current (Program/Erase) *2	$I_{CC2}f$	$\overline{CE}f$ = V_{IL}, $\overline{OE}$ = V_{IH}		—	—	35	mA
Flash V_{CC} Active Current (Read-While-Program) *5	$I_{CC3}f$	$\overline{CE}f$ = V_{IL}, $\overline{OE}$ = V_{IH}		—	—	53	mA
Flash V_{CC} Active Current (Read-While-Erase) *5	$I_{CC4}f$	$\overline{CE}f$ = V_{IL}, $\overline{OE}$ = V_{IH}		—	—	53	mA
Flash V_{CC} Active Current (Erase-Suspend-Program)	$I_{CC5}f$	$\overline{CE}f$ = V_{IL}, $\overline{OE}$ = V_{IH}		—	—	35	mA
FCRAM V_{CC} Active Current	$I_{CC1}s$	$V_{CC}s$ = $V_{CC}s$ Max, $\overline{CE1}s$ = V_{IL}, CE2s = V_{IH}, V_{IN} = V_{IH} or V_{IL}, I_{OUT} = 0 mA	t_{RC} / t_{WC} =Min	—	15	20	mA
			t_{RC} / t_{WC} =Max	—	2.5	3.0	
Flash V_{CC} Standby Current	$I_{SB1}f$	$V_{CC}f$ = $V_{CC}f$ Max, $\overline{CE}f$ = $V_{CC}f$ ± 0.3 V $\overline{RESET}$ = $V_{CC}f$ ± 0.3 V, $\overline{WP}$/ACC = $V_{CC}f$± 0.3 V		—	1	5	µA
Flash V_{CC} Standby Current ($\overline{RESET}$)	$I_{SB2}f$	$V_{CC}f$ = $V_{CC}f$ Max, $\overline{RESET}$ = V_{SS} ± 0.3 V, $\overline{WP}$/ACC = $V_{CC}f$± 0.3 V		—	1	5	µA
Flash V_{CC} Current (Automatic Sleep Mode) *3	$I_{SB3}f$	$V_{CC}f$ = $V_{CC}f$ Max, $\overline{CE}f$ = V_{SS} ± 0.3 V $\overline{RESET}$ = $V_{CC}f$ ± 0.3 V, $\overline{WP}$/ACC = $V_{CC}f$± 0.3 V V_{IN} = $V_{CC}f$± 0.3 V or V_{SS} ± 0.3 V		—	1	5	µA
FCRAM V_{CC} Standby Current	$I_{SB}s$	$V_{CC}s$ = $V_{CC}s$ Max,$\overline{CE1}s$ = CE2s = V_{IH}, V_{IN} = V_{IH} or V_{IL}, I_{OUT} = 0 mA		—	0.5	1	mA
FCRAM V_{CC} Standby Current	$I_{SB1}s$	$V_{CC}s$ = $V_{CC}s$ Max,$\overline{CE1}s \geq V_{CC}s$ – 0.2 V, CE2s ≥ $V_{CC}s$– 0.2 V, $V_{IN} \leq$ 0.2 V or $V_{CC}s$ – 0.2 V, I_{OUT} = 0 mA		—	—	70	µA
FCRAM V_{CC} Standby Current	$I_{SB2}s$	$V_{CC}s$ = $V_{CC}s$ Max,$\overline{CE1}s \geq V_{CC}s$ – 0.2 V, CE2s ≥ $V_{CC}s$– 0.2 V, V_{IN} Cycle time = t_{RC} Min, I_{OUT} = 0 mA		—	—	5 *6	mA
FCRAM V_{CC} Power Down Current	$I_{PD}s$	$V_{CC}s$ = $V_{CC}s$ Max, $V_{IN} \geq V_{CC}f$ – 0.2 V or $V_{IN} \leq$ 0.2 V CE2s ≤ 0.2 V, I_{OUT} = 0 mA		—	—	10	µA

(Continued)

(Continued)

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Input Low Level	V_{IL}	—	–0.3	—	0.4	V
Input High Level	V_{IH}	—	2.3	—	V_{CC}+0.3	V
Voltage for Autoselect and Sector Protection ($\overline{RESET}$) *4	V_{ID}	—	11.5	—	12.5	V
Voltage for $\overline{WP}$/ACC Sector Protection/Unprotection and Program Acceleration	V_{ACC}	—	8.5	9.0	9.5	V
FCRAM Output Low Level	V_{OL}	$V_{CC}s$ = $V_{CC}s$ Min, I_{OL} =1.0 mA	—	—	0.4	V
FCRAM Output High Level	V_{OH}	$V_{CC}s$ = $V_{CC}s$ Min, I_{OH} = –0.5 mA	2.1	—	—	V
Flash Output Low Level	V_{OL}	$V_{CC}f$ = $V_{CC}f$ Min, I_{OL} = 4.0 mA	—	—	0.45	V
Flash Output High Level	V_{OH}	$V_{CC}f$ = $V_{CC}f$ Min, I_{OH} = –0.1 mA	$V_{CC}f$– 0.4	—	—	V
Low Vcc Lock-Out Voltage	V_{LKO}	—	2.3	—	2.5	V

*1: The I_{CC} current listed includes both the DC operating current and the frequency dependent component.

*2: I_{CC} active while Embedded Algorithm (program or erase) is in progress.

*3: Automatic sleep mode enables the low power mode when address remains stable for 150 ns.

*4: Applicable for only V_{CC} applying.

*5: Embedded Algorithm (program or erase) is in progress. (@5MHz)

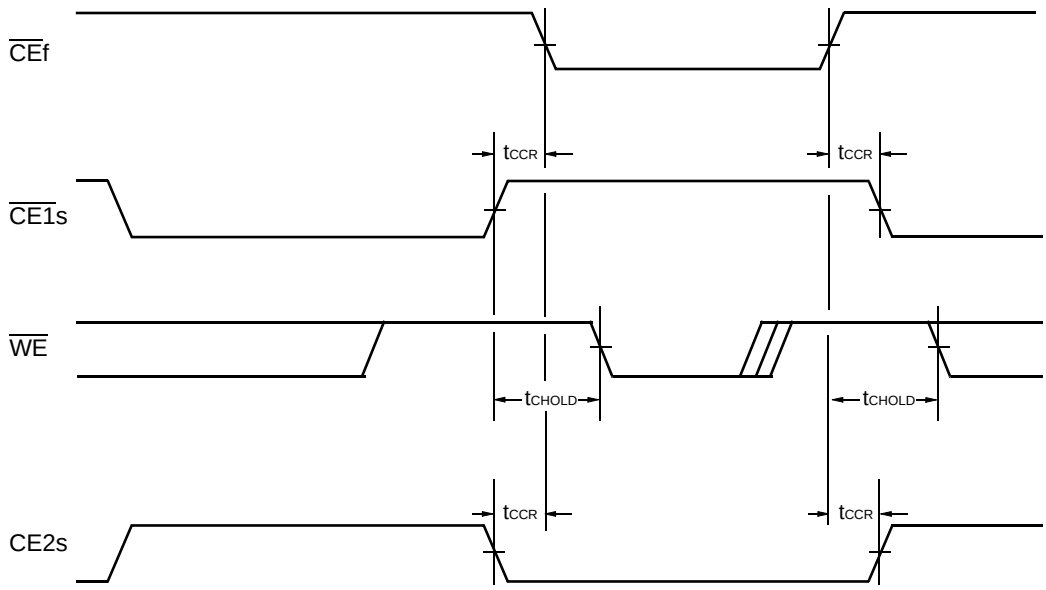
*6: $I_{SB2}s$ depends on V_{IN} cycle time. Refer to “■ APPENDIX”.

■ AC CHARACTERISTICS

• $\overline{CE}$ Timing

Parameter	Symbol		Condition	Value		Unit
	JEDEC	Standard		Min	Max	
$\overline{CE}$ Recover Time	—	t_{CCR}	—	0	—	ns
$\overline{CE}$ Hold Time	—	t_{CHOLD}	—	3	—	ns

• Timing Diagram for alternating FCRAM to Flash

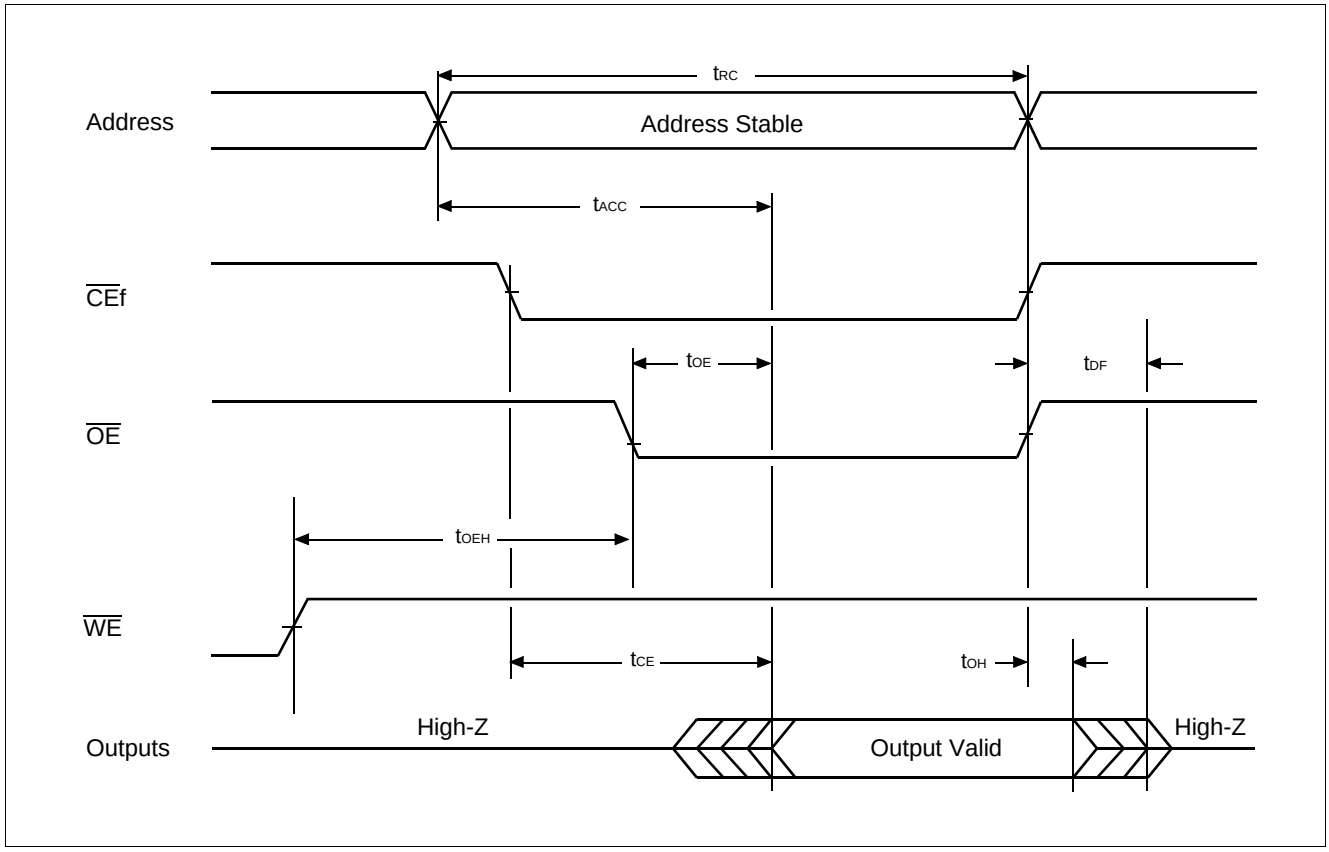


• **Read Only Operations Characteristics (Flash)**

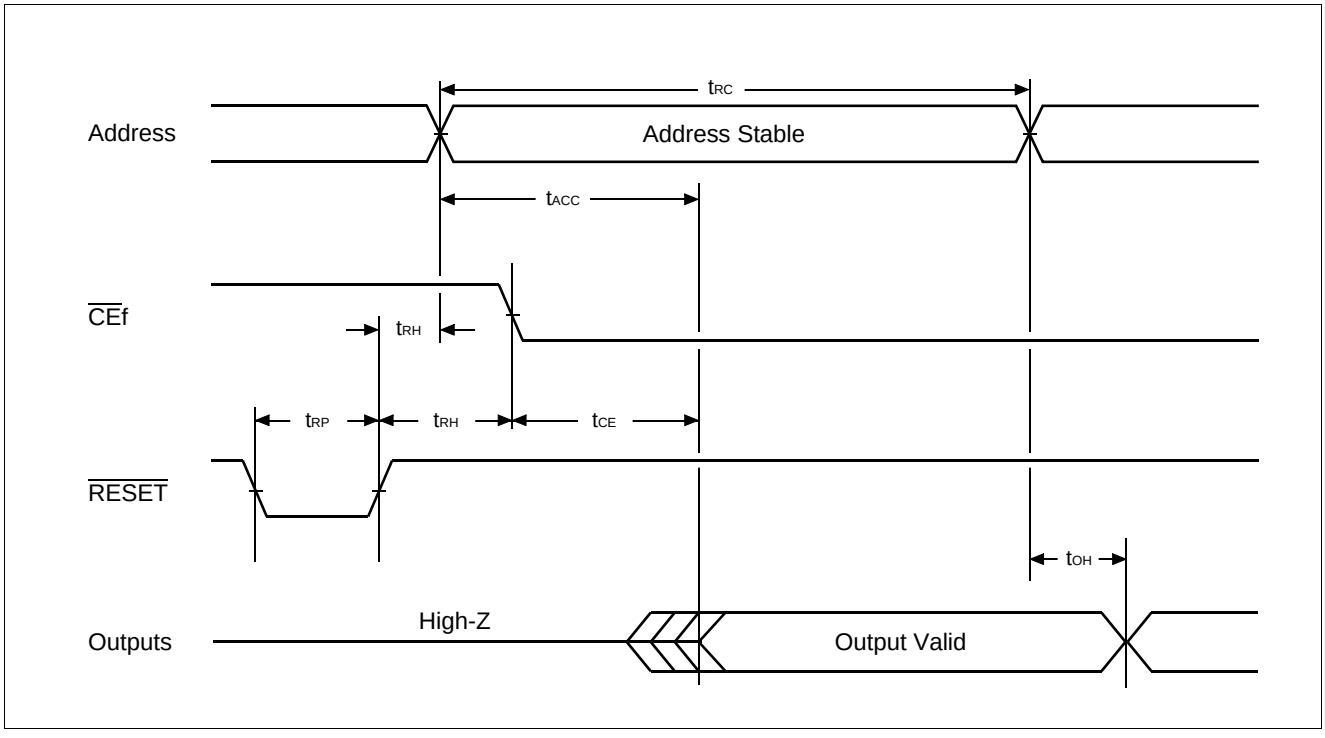
Parameter	Symbol		Conditions	Value		Unit
	JEDEC	Standard		Min	Max	
Read Cycle Time	t_{AVAV}	t_{RC}	—	85	—	ns
Address to Output Delay	t_{AVQV}	t_{ACC}	$\overline{CE}f = V_{IL}$ $\overline{OE} = V_{IL}$	—	85	ns
Chip Enable to Output Delay	t_{ELQV}	t_{CE}	$\overline{OE} = V_{IL}$	—	85	ns
Output Enable to Output Delay	t_{GLQV}	t_{OE}	—	—	35	ns
Chip Enable to Output High-Z	t_{EHQZ}	t_{DF}	—	—	30	ns
Output Enable to Output High-Z	t_{GHQZ}	t_{DF}	—	—	30	ns
Output Hold Time From Addresses, $\overline{CE}f$ or $\overline{OE}$, Whichever Occurs First	t_{AXQX}	t_{OH}	—	0	—	ns
$\overline{RESET}$ Pin Low to Read Mode	—	t_{READY}	—	—	20	µs

Note: Test Conditions– Output Load: 1 TTL gate and 30 pF
Input rise and fall times: 5 ns
Input pulse levels: 0.0 V or V_{CC}
Timing measurement reference level
Input: $0.5 \times V_{CC}$
Output: $0.5 \times V_{CC}$

• **Read Cycle (Flash)**



• **Hardware Reset/Read Operation Timing Diagram (Flash)**



• **Erase/Program Operations Characteristics (Flash)**

Parameter		Symbol		Value			Unit
		JEDEC	Standard	Min	Typ	Max	
Write Cycle Time		t_{AVAV}	t_{WC}	85	—	—	ns
Address Setup Time ($\overline{WE}$ to Addr.)		t_{AVWL}	t_{AS}	0	—	—	ns
Address Setup Time to $\overline{CE}$f Low During Toggle Bit Polling		—	t_{ASO}	15	—	—	ns
Address Hold Time ($\overline{WE}$ to Addr.)		t_{WLAX}	t_{AH}	45	—	—	ns
Address Hold Time from $\overline{CE}$f or $\overline{OE}$ High During Toggle Bit Polling		—	t_{AHT}	0	—	—	ns
Data Setup Time		t_{DVWH}	t_{DS}	35	—	—	ns
Data Hold Time		t_{WHDX}	t_{DH}	0	—	—	ns
Output Enable Setup Time		—	t_{OES}	0	—	—	ns
Output Enable Hold Time	Read	—	t_{OEH}	0	—	—	ns
	Toggle and $\overline{Data}$ Polling			10	—	—	ns
$\overline{CE}$f High During Toggle Bit Polling		—	t_{CEPH}	20	—	—	ns
$\overline{OE}$ High During Toggle Bit Polling		—	t_{OEPH}	20	—	—	ns
Read Recover Time Before Write ($\overline{OE}$ to $\overline{CE}$f)		t_{GHEL}	t_{GHEL}	0	—	—	ns
Read Recover Time Before Write ($\overline{OE}$ to $\overline{WE}$)		t_{GHWL}	t_{GHWL}	0	—	—	ns
$\overline{WE}$ Setup Time ($\overline{CE}$f to $\overline{WE}$)		t_{WLEL}	t_{WS}	0	—	—	ns
$\overline{CE}$f Setup Time ($\overline{WE}$ to $\overline{CE}$f)		t_{ELWL}	t_{CS}	0	—	—	ns
$\overline{WE}$ Hold Time ($\overline{CE}$f to $\overline{WE}$)		t_{EHWH}	t_{WH}	0	—	—	ns
$\overline{CE}$f Hold Time ($\overline{WE}$ to $\overline{CE}$f)		t_{WHEH}	t_{CH}	0	—	—	ns
Write Pulse Width		t_{WLWH}	t_{WP}	35	—	—	ns
$\overline{CE}$f Pulse Width		t_{ELEH}	t_{CP}	35	—	—	ns
Write Pulse Width High		t_{WHWL}	t_{WPH}	30	—	—	ns
$\overline{CE}$f Pulse Width High		t_{EHEL}	t_{CPH}	30	—	—	ns
Word Programming Operation		t_{WHWH1}	t_{WHWH1}	—	16	—	µs
Sector Erase Operation *1		t_{WHWH2}	t_{WHWH2}	—	1	—	s

(Continued)

(Continued)

Parameter	Symbol		Value			Unit
	JEDEC	Standard	Min	Typ	Max	
V_{CC}f Setup Time	—	t_{VCS}	50	—	—	µs
Voltage Transition Time *2	—	t_{VLHT}	4	—	—	µs
Rise Time to V_{ID} *2	—	t_{VIDR}	500	—	—	ns
Rise Time to V_{ACC}	—	t_{VACCR}	500	—	—	ns
Recover Time from RY/$\overline{BY}$	—	t_{RB}	0	—	—	ns
$\overline{RESET}$ Pulse Width	—	t_{RP}	500	—	—	ns
Delay Time from Embedded Output Enable	—	t_{EOE}	—	—	85	ns
$\overline{RESET}$ Hold Time Before Read	—	t_{RH}	200	—	—	ns
Program/Erase Valid to RY/$\overline{BY}$ Delay	—	t_{BUSY}	—	—	90	ns
Erase Time-out Time *3	—	t_{TOW}	50	—	—	µs
Erase Suspend Transition Time *4	—	t_{SPD}	—	—	20	µs

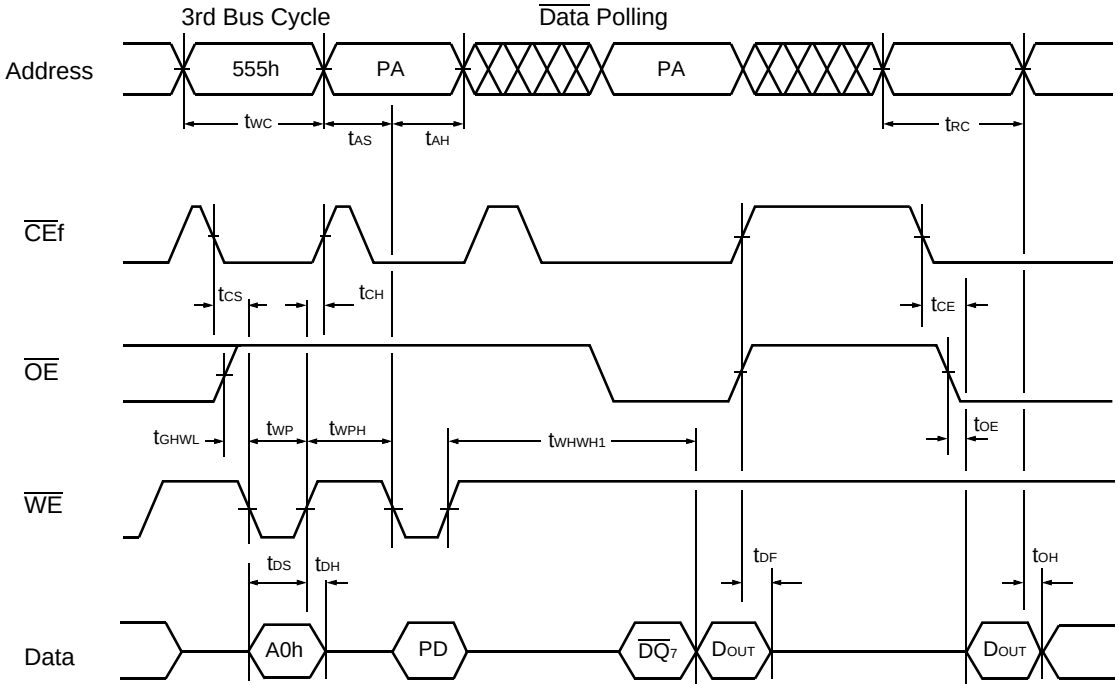
*1: This does not include the preprogramming time.

*2: This timing is for Sector Protection Operation.

*3: The time between writes must be less than “t_{TOW}” otherwise that command will not be accepted and erasure will start. A time-out or “t_{TOW}” from the rising edge of last $\overline{CE}$f or $\overline{WE}$ whichever happens first will initiate the execution of the Sector Erase command(s).

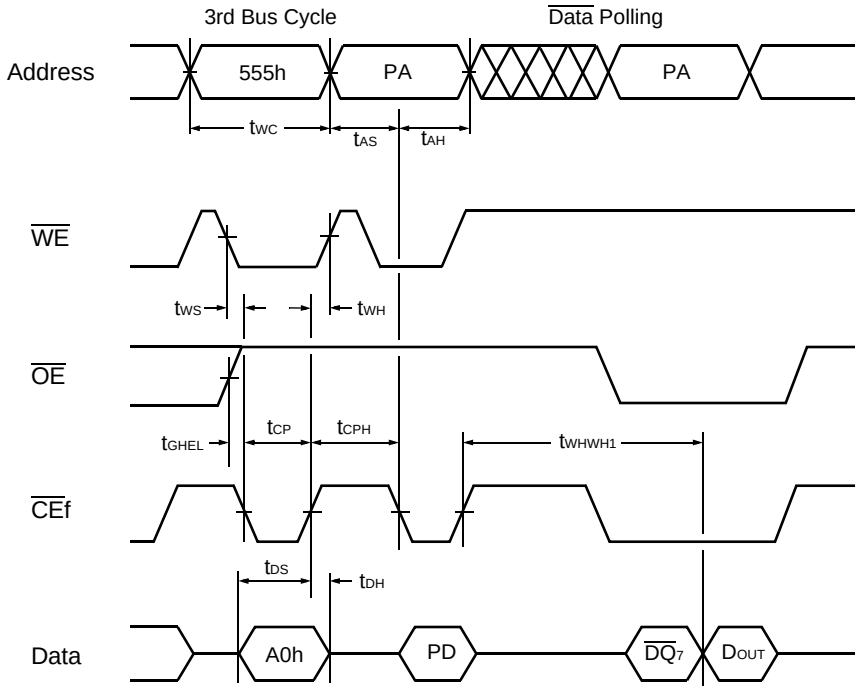
*4: When the Erase Suspend command is written during the Sector Erase operation, the device will take a maximum of “t_{SPD}” to suspend the erase operation.

• **Write Cycle ($\overline{WE}$ control) (Flash)**



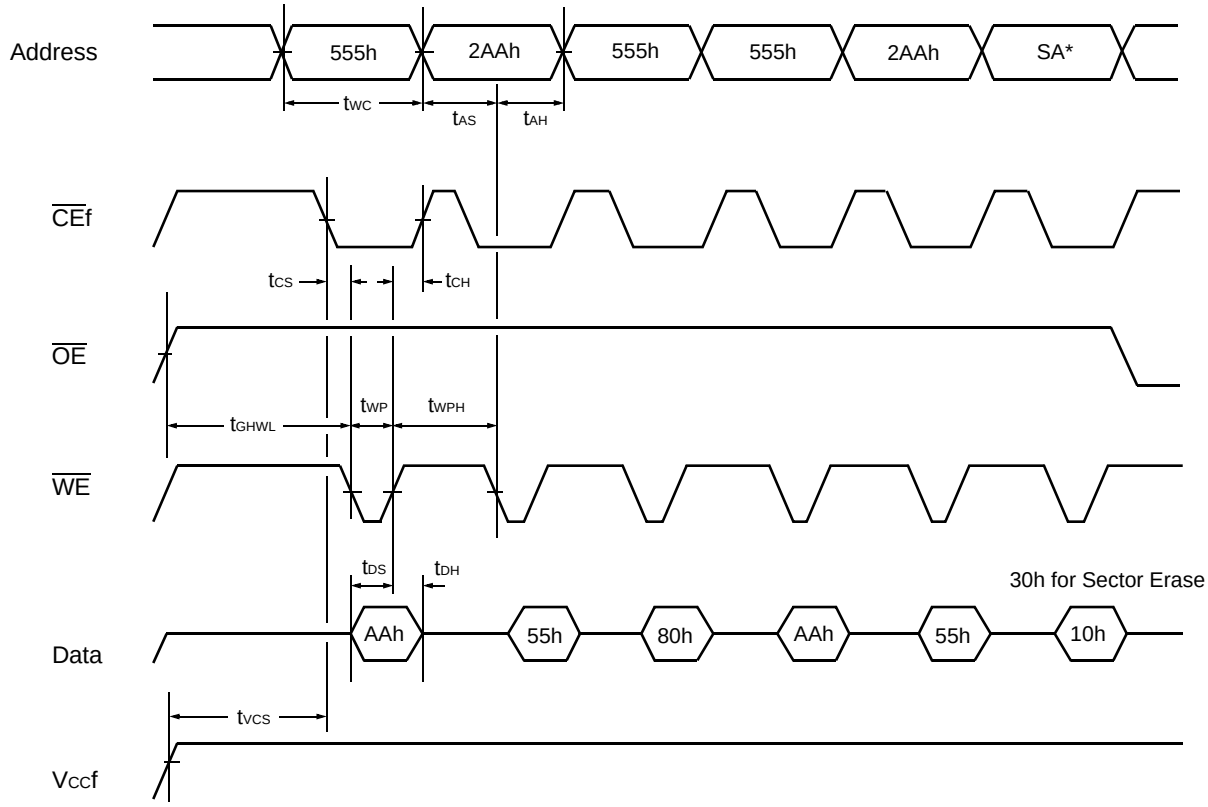
Notes: • PA is an address of the memory location to be programmed.
• PD is data to be programmed at the word address.
• $\overline{DQ_7}$ is the output of the data complement written to the device.
• D_{OUT} is the data output written to the device.
• Figure indicates the last two out of four bus cycle sequence.

• **Write Cycle ($\overline{CE}$f control) (Flash)**



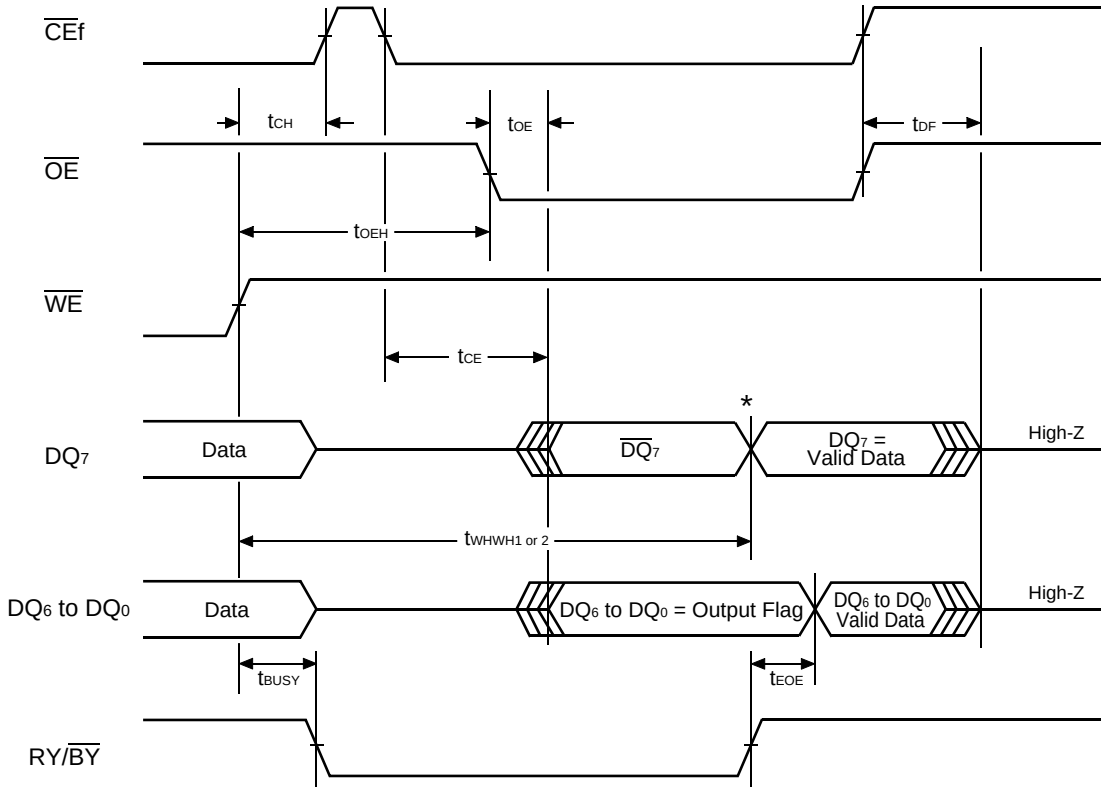
Notes: • PA is an address of the memory location to be programmed.
• PD is data to be programmed at the word address.
• $\overline{DQ}_7$ is the output of the data complement written to the device.
• D_{OUT} is the data output written to the device.
• Figure indicates the last two out of four bus cycle sequence.

• **AC Waveforms Chip/Sector Erase Operations (Flash)**



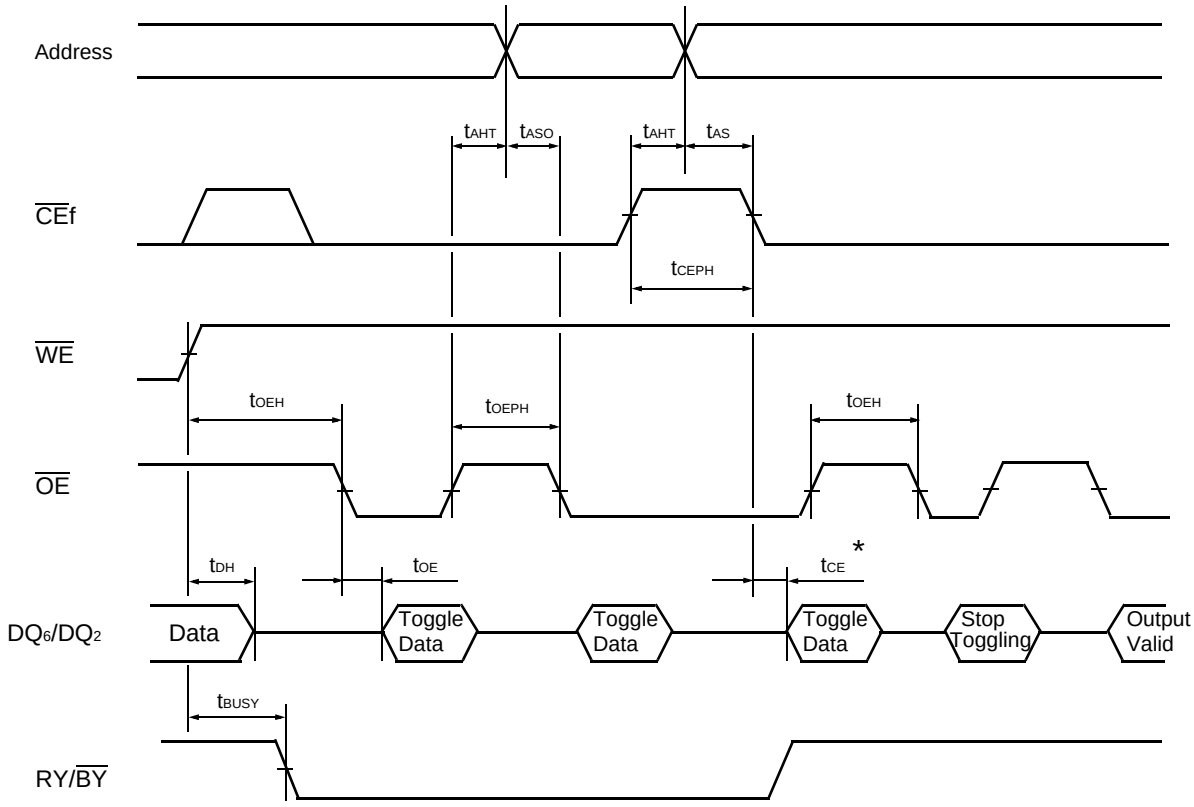
*: SA is the sector address for Sector Erase. Addresses = 555h for Chip Erase.

• **AC Waveforms for $\overline{\text{Data}}$ Polling during Embedded Algorithm Operations (Flash)**



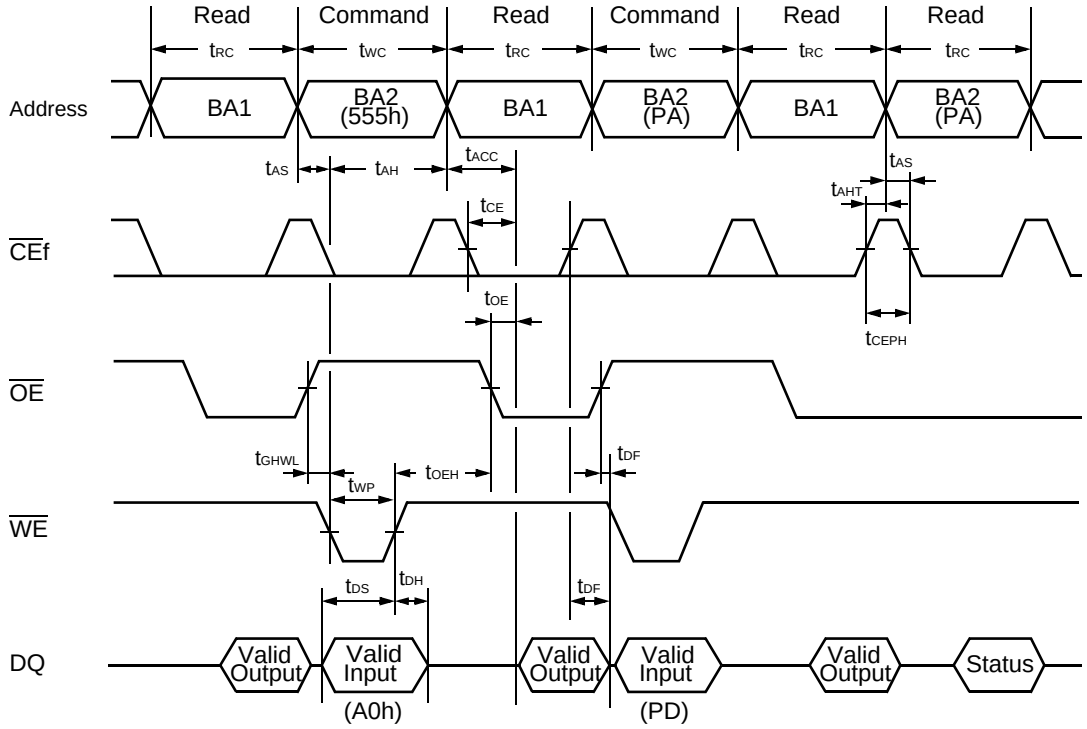
* : DQ_7 = Valid Data (the device has completed the Embedded operation).

• **AC Waveforms for Toggle Bit during Embedded Algorithm Operations (Flash)**



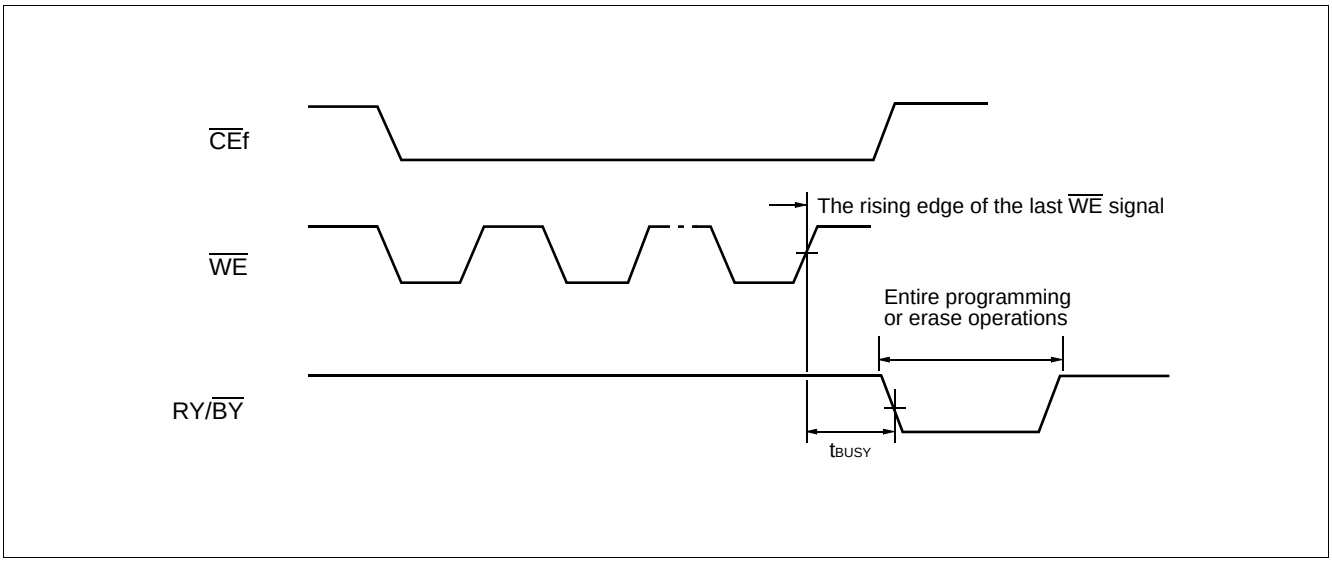
* : DQ_6 stops toggling (the device has completed the Embedded operation).

• **Back-to-back Read/Write Timing Diagram (Flash)**

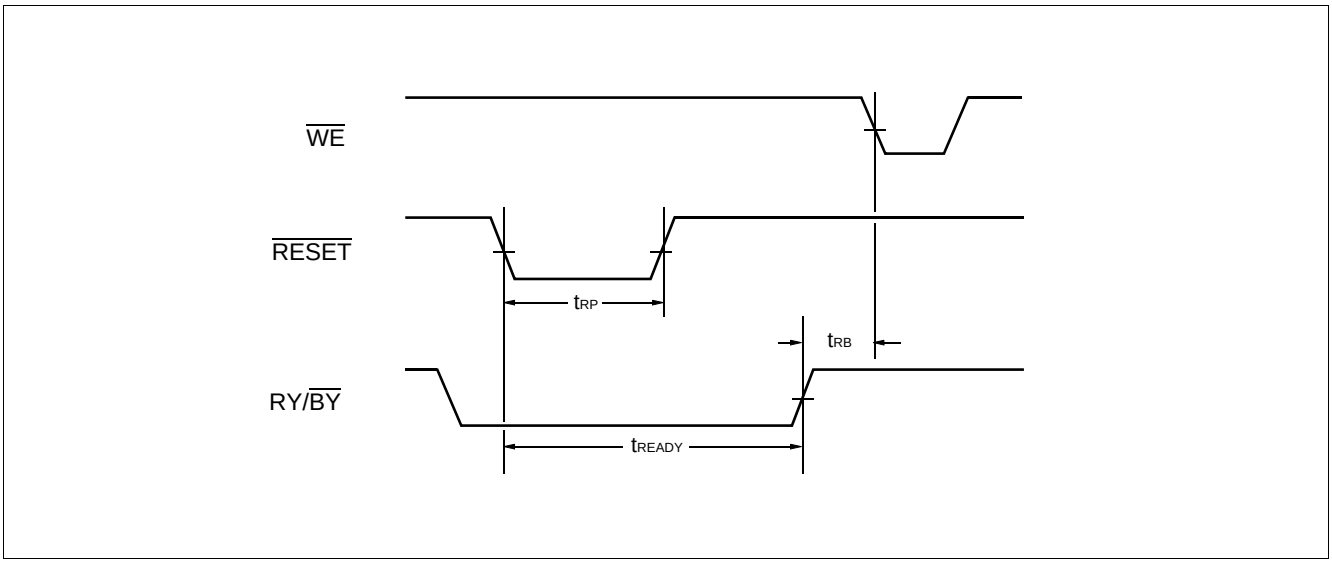


Note: This is an example of Read for Bank 1 and Embedded Algorithm (program) for Bank 2.
BA1: Address of Bank 1.
BA2: Address of Bank 2.

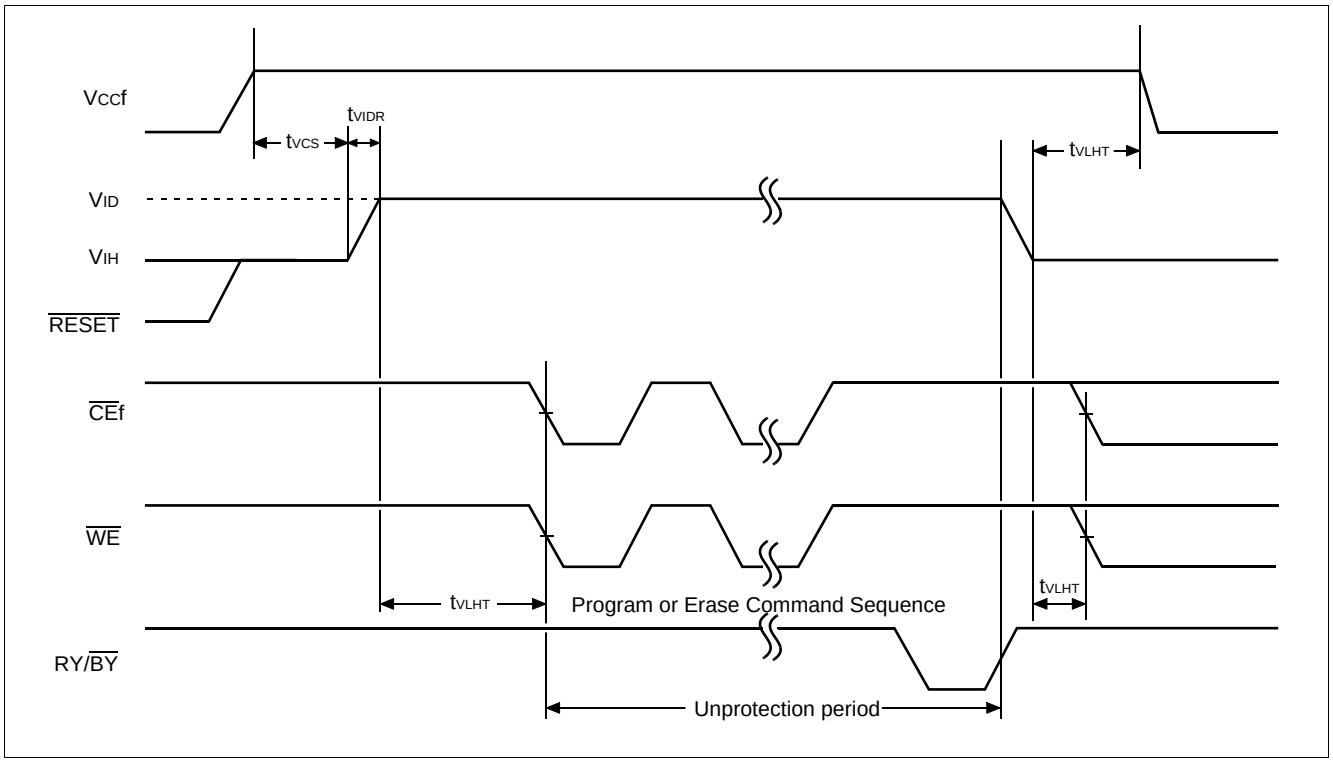
• **RY/$\overline{BY}$ Timing Diagram during Write/Erase Operations (Flash)**



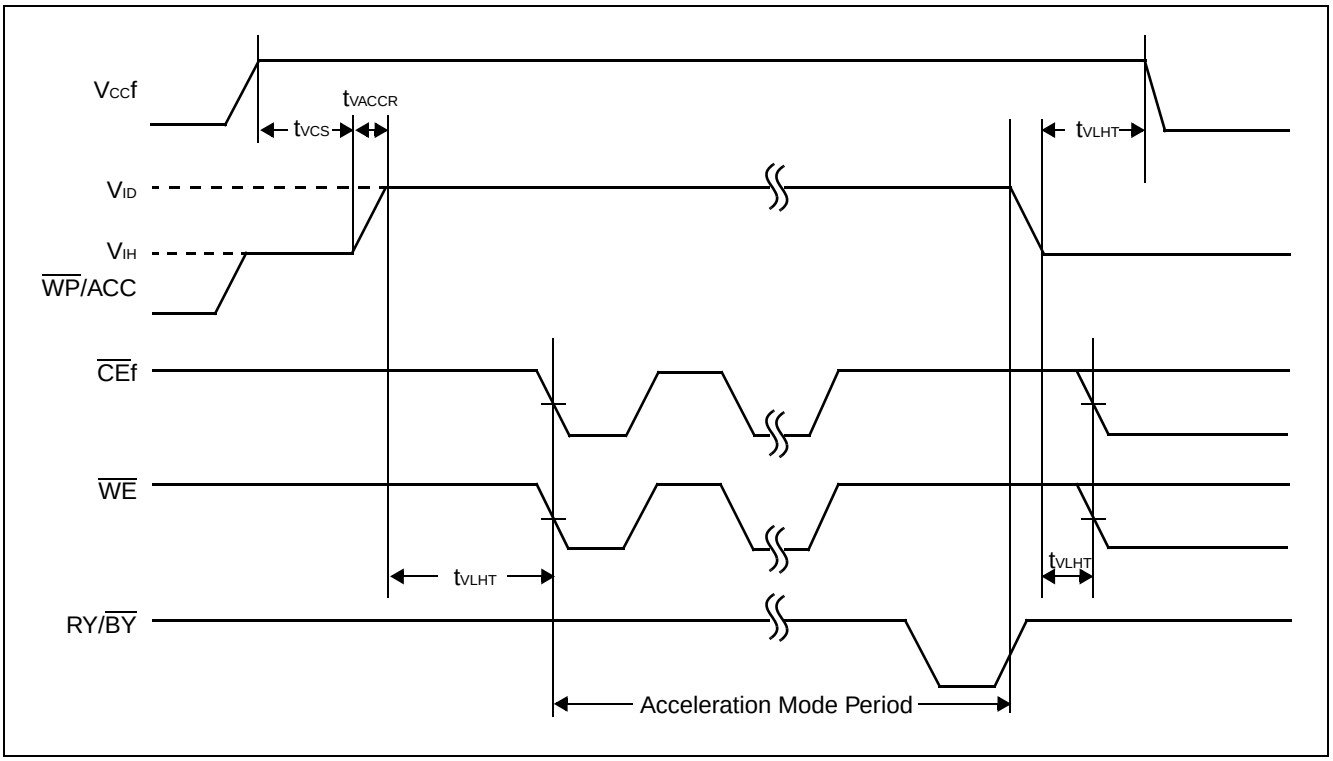
• **RY/$\overline{BY}$ Timing Diagram during Write/Erase Operations (Flash)**



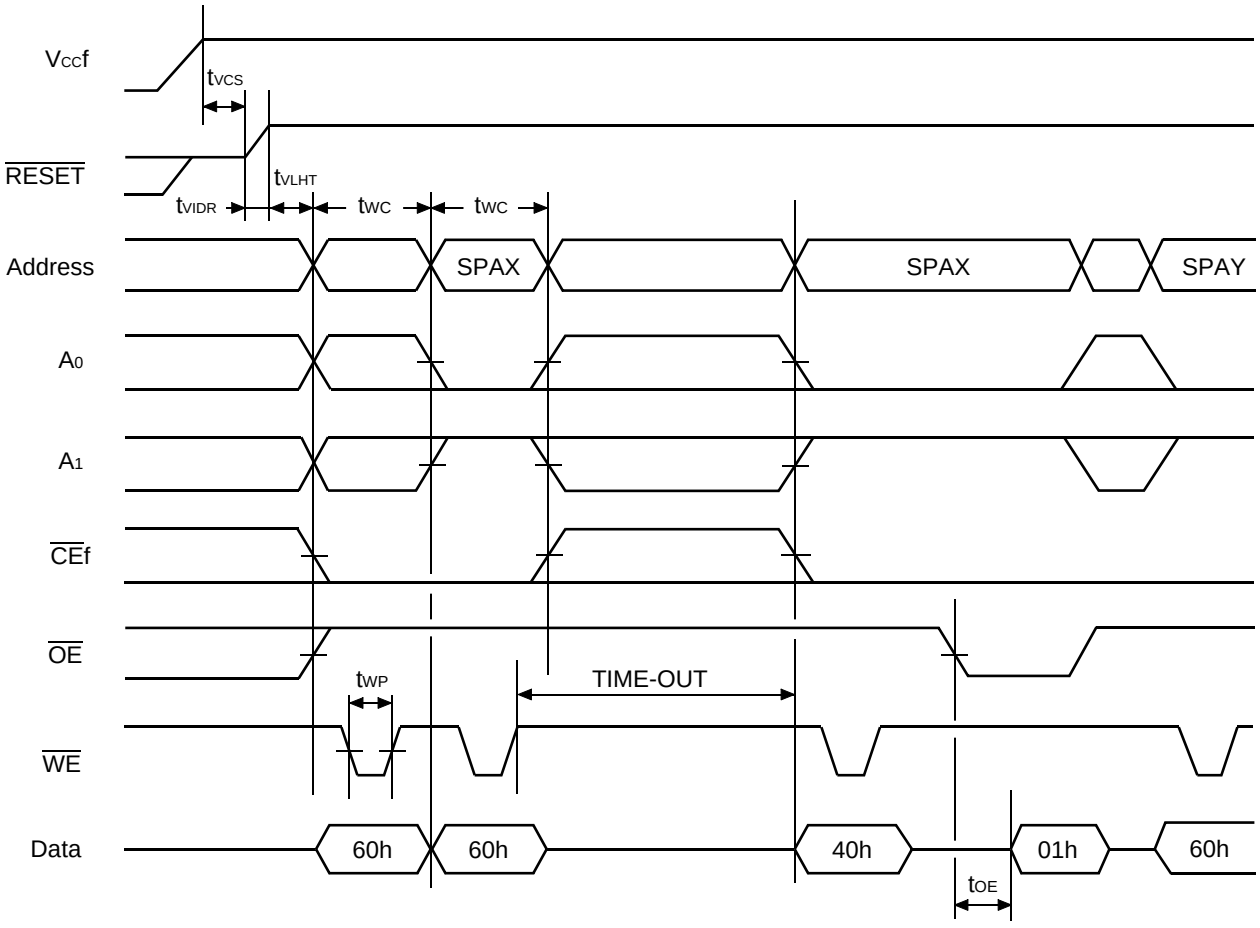
• Temporary Sector Group Unprotection (Flash)



• Acceleration Mode Timing Diagram (Flash)



• **Extended Sector Group Protection (Flash)**



SPAX: Sector Group Address to be protected
SPAY : Next Sector Group Address to be protected
TIME-OUT : Time-Out window = 250 μs (Min)

- **READ OPERATION (FCRAM)**

Parameter	Symbol	Value		Unit	Notes
		Min	Max		
Read Cycle Time	t_{RC}	90	—	ns	
Chip Enable Access Time	t_{CE}	—	85	ns	*1, *3
Output Enable Access Time	t_{OE}	—	45	ns	*1
Chip Enable Access Time	t_{AA}	—	85	ns	*1, *4
Output Data Hold Time	t_{OH}	5	—	ns	*1
$\overline{CE1}$s Low to Output Low-Z	t_{CLZ}	5	—	ns	*2
$\overline{OE}$ Low to Output Low-Z	t_{OLZ}	0	—	ns	*2
$\overline{CE1}$s High to Output High-Z	t_{CHZ}	—	30	ns	*2
$\overline{OE}$ High to Output High-Z	t_{OHZ}	—	25	ns	*2
Address Setup Time to $\overline{CE1}$s Low	t_{ASC}	–5	—	ns	*5
Address Setup Time to $\overline{OE}$	t_{ASO}	45	—	ns	*3, *6
	$t_{ASO[ABS]}$	10	—	ns	*7
Address Invalid Time	t_{AX}	—	5	ns	*4
$\overline{CE1}$s Low to Address Hold Time	t_{CLAH}	90	—	ns	*4
$\overline{OE}$ Low to Address Hold Time	t_{OLAH}	45	—	ns	*4, *8
$\overline{CE1}$s High to Address Hold Time	t_{CHAH}	–5	—	ns	
$\overline{OE}$ High to Address Hold Time	t_{OHAH}	–5	—	ns	
$\overline{CE1}$s Low to $\overline{OE}$ Low Delay Time	t_{CLOL}	45	1000	ns	*4, *6, *8, *9
$\overline{OE}$ Low to $\overline{CE1}$s High Delay Time	t_{OLCH}	45	—	ns	*8
$\overline{CE1}$s High Pulse Width	t_{CP}	20	—	ns	
$\overline{OE}$ High Pulse Width	t_{OP}	45	1000	ns	*6, *8, *9
	$t_{OP[ABS]}$	20	—	ns	*7

*1: The output load is 30 pF.

*2: The output load is 5 pF.

*3: The t_{CE} is applicable if $\overline{OE}$ is brought to Low before $\overline{CE1}$s goes Low and is also applicable if actual value of both or either t_{ASO} or t_{CLOL} is shorter than specified value.

*4: Applicable only to A_0 and A_1 when both $\overline{CE1}$s and $\overline{OE}$ are kept at Low for the address access.

*5: Applicable if $\overline{OE}$ is brought to Low before $\overline{CE1}$s goes Low.

*6: The t_{ASO}, t_{CLOL} (Min) and t_{OP} (Min) are reference values when the access time is determined by t_{OE}.
If actual value of each parameter is shorter than specified minimum value, t_{OE} becomes longer by the amount of subtracting actual value from specified minimum value.
For example, if actual t_{ASO}, t_{ASO} (actual) , is shorter than specified minimum value, t_{ASO} (Min) , during $\overline{OE}$ control access (i.e., $\overline{CE1}$s stays Low) , the t_{OE} becomes t_{OE} (Max) + t_{ASO} (Min) – t_{ASO} (actual) .

*7: The $t_{ASO[ABS]}$ and $t_{OP[ABS]}$ are the absolute minimum values during $\overline{OE}$ control access.

*8: If actual value of either t_{CLOL} or t_{OP} is shorter than specified minimum value, both t_{OLAH} and t_{OLCH} become t_{RC} (Min) – t_{CLOL} (actual) or t_{RC} (Min) – t_{OP} (actual) .

*9: Maximum value is applicable if $\overline{CE1}$s is kept at Low.

• **WRITE OPERATION (FCRAM)**

Parameter	Symbol	Value		Unit	Notes
		Min	Max		
Write Cycle Time	t_{WC}	90	—	ns	*1
Address Setup Time	t_{AS}	0	—	ns	*2
Address Hold Time	t_{AH}	45	—	ns	*2
$\overline{CE1}$s Write Setup Time	t_{CS}	0	1000	ns	
$\overline{CE1}$s Write Hold Time	t_{CH}	0	1000	ns	
$\overline{WE}$ Setup Time	t_{WS}	0	—	ns	
$\overline{WE}$ Hold Time	t_{WH}	0	—	ns	
$\overline{LB}$s and $\overline{UB}$s Setup Time	t_{BS}	0	—	ns	
$\overline{LB}$s and $\overline{UB}$s Hold Time	t_{BH}	–5	—	ns	
$\overline{OE}$ Setup Time	t_{OES}	0	1000	ns	*3
$\overline{OE}$ Hold Time	t_{OEH}	45	1000	ns	*3, *4
	$t_{OEH[ABS]}$	20	—	ns	*5
$\overline{OE}$ High to $\overline{CE1}$s Low Setup Time	t_{OHCL}	–3	—	ns	*6
$\overline{OE}$ High to Address Hold Time	t_{OHAH}	–5	—	ns	*7
$\overline{CE1}$s Write Pulse Width	t_{CW}	60	—	ns	*1, *8
$\overline{WE}$ Write Pulse Width	t_{WP}	60	—	ns	*1, *8
$\overline{CE1}$s Write Recovery Time	t_{WRC}	15	—	ns	*1, *9
$\overline{WE}$ Write Recovery Time	t_{WR}	15	1000	ns	*1, *3, *9
Data Setup Time	t_{DS}	20	—	ns	
Data Hold Time	t_{DH}	0	—	ns	
$\overline{CE1}$s High Pulse Width	t_{CP}	20	—	ns	*9

*1: Minimum value must be equal or greater than the sum of actual t_{CW} (or t_{WP}) and t_{WRC} (or t_{WR}) .

*2: New write address is valid from either $\overline{CE1}$s or $\overline{WE}$ that is brought to High.

*3: Maximum value is applicable if $\overline{CE1}$s is kept at Low and both $\overline{WE}$ and $\overline{OE}$ are kept at High.

*4: The t_{OEH} is specified from end of t_{WC} (Min) , and is a reference value when access time is determined by t_{OE}.
If actual value is shorter than specified minimum value, t_{OE} becomes longer by the amount of subtracting actual value from specified minimum value.

*5: The $t_{OEH[ABS]}$ is the absolute minimum value if write cycle is terminated by $\overline{WE}$ and $\overline{CE1}$s stays Low.

*6: t_{OHCL} (Min) must be satisfied if read operation is not performed prior to write operation.
In case $\overline{OE}$ is disabled after t_{OHCL} (Min) , $\overline{WE}$ Low must be asserted after t_{RC} (Min) from $\overline{CE1}$s Low.
In other words, read operation is initiated if t_{OHCL} (Min) is not satisfied.

*7: Applicable if $\overline{CE1}$s stays Low after read operation.

*8: t_{CW} and t_{WP} are applicable if write operation is initiated by $\overline{CE1}$s and $\overline{WE}$, respectively.

*9: t_{WRC} and t_{WR} are applicable if write operation is terminated by $\overline{CE1}$s and $\overline{WE}$, respectively.
The t_{WR} (Min) can be ignored if $\overline{CE1}$s is brought to High together or after $\overline{WE}$ is brought to High.
In such a case, the t_{CP} (Min) must be satisfied.

• POWER DOWN PARAMETER (FCRAM)

Parameter	Symbol	Value		Unit	Note
		Min	Max		
CE2s Low Setup Time for Power Down Entry	t_{CSP}	10	—	ns	
CE2s Low Hold Time after Power Down Entry	t_{C2LP}	100	—	ns	
$\overline{CE1}$s High Hold Time following CE2s High after Power Down Exit	t_{CHH}	350	—	µs	
$\overline{CE1}$s High Setup Time following CE2s High after Power Down Exit	t_{CHS}	10	—	ns	

• OTHER TIMING PARAMETER (FCRAM)

Parameter	Symbol	Value		Unit	Note
		Min	Max		
$\overline{CE1}$s High to $\overline{OE}$ Invalid Time for Standby Entry	t_{CHOX}	20	—	ns	
$\overline{CE1}$s High to $\overline{WE}$ Invalid Time for Standby Entry	t_{CHWX}	20	—	ns	*1
CE2s Low Hold Time after Power-up	t_{C2LH}	50	—	µs	*2
CE2s High Hold Time after Power-up	t_{C2HL}	50	—	µs	*3
$\overline{CE1}$s High Hold Time following CE2s High after Power-up	t_{CHH}	350	—	µs	*2
Input Transition Time	t_T	1	25	ns	*4

*1: It may write date into any address location t_{CHWX} is not satisfied.

*2: Must satisfy t_{CHH} (Min) after t_{C2LH} (Min) .

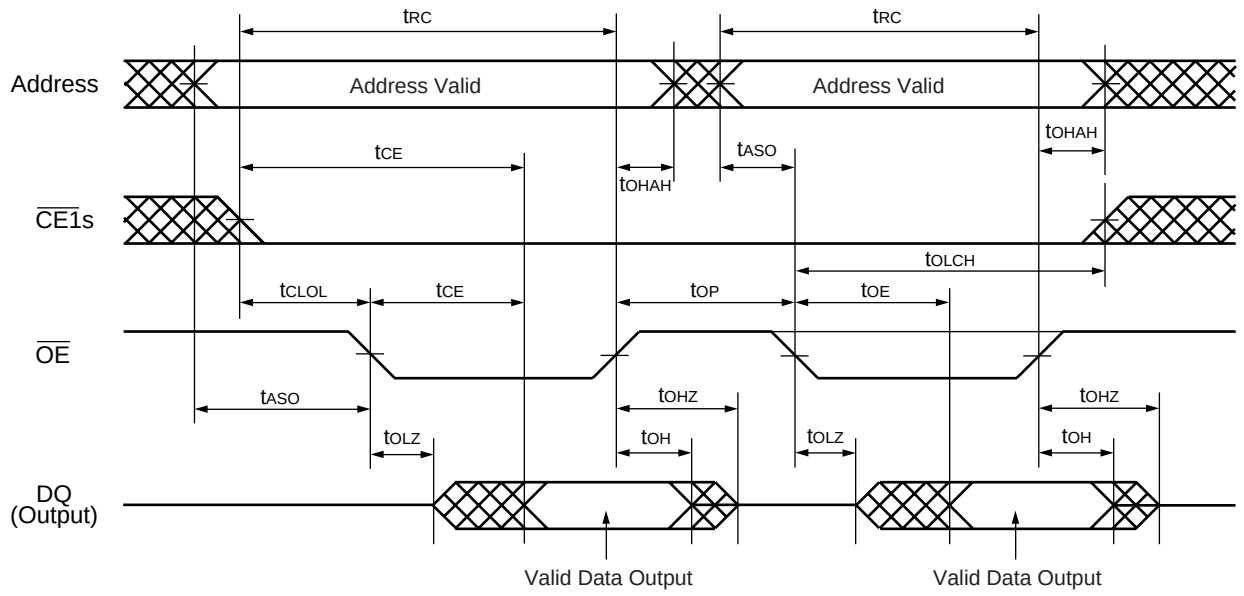
*3: Requires Power Down mode entry and exit after t_{C2HL}.

*4: The Input Transition Time (t_T) at AC testing is 5 ns as shown below. If actual t_T is longer than 5 ns, it may violate AC specification of some timing parameters.

• AC TEST CONDITIONS (FCRAM)

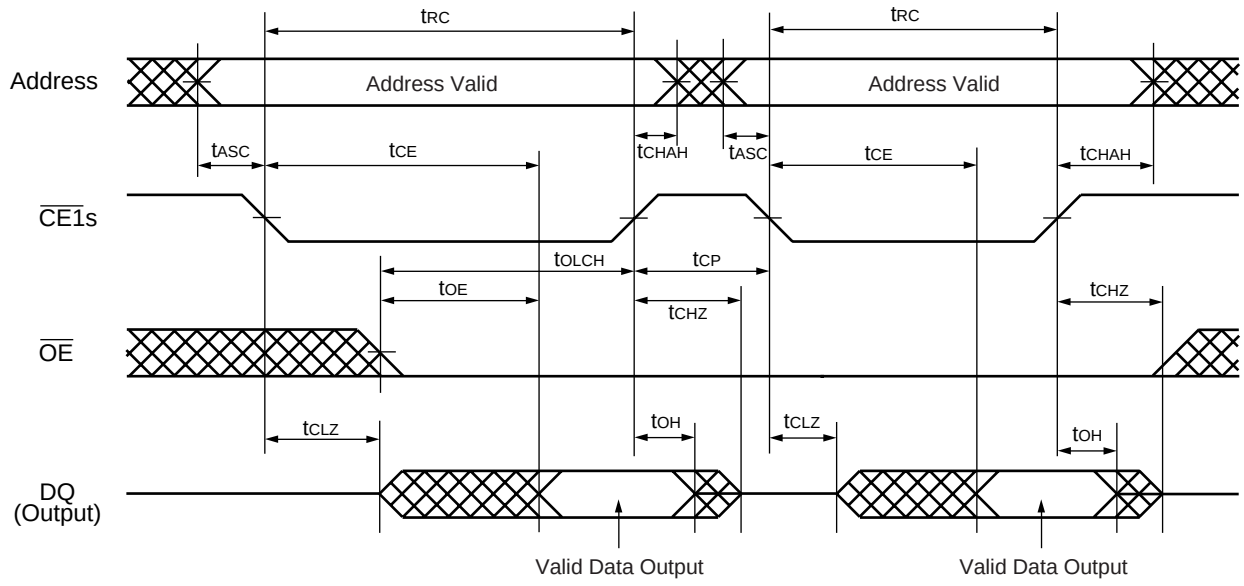
Parameter	Symbol	Condition	Value	Unit	Note
Input High Level	V_{IH}	V_{CCS} = 2.7 V to 3.1 V	2.3	V	
Input Low Level	V_{IL}	V_{CCS} = 2.7 V to 3.1 V	0.4	V	
Input Timing Measurement Level	V_{REF}	V_{CCS} = 2.7 V to 3.1 V	1.3	V	
Input Transition Time	t_T	Between V_{IL} and V_{IH}	5	ns	

• READ Timing #1 ($\overline{OE}$ Control Access) (FCRAM)



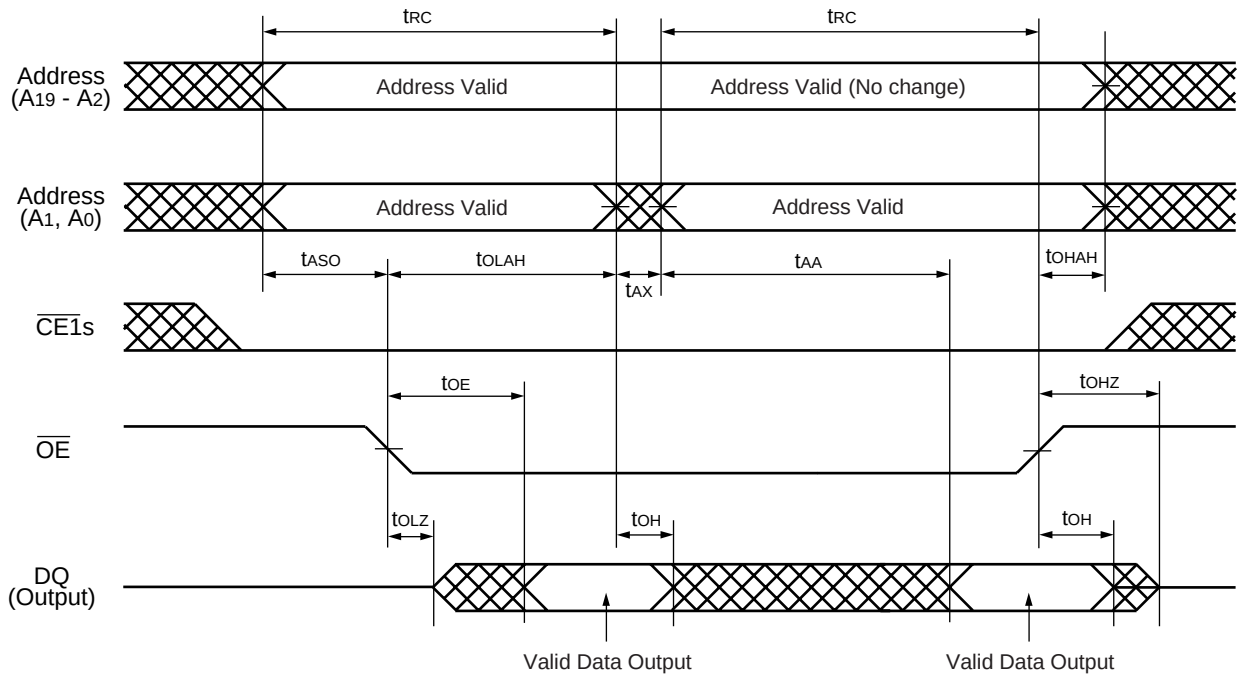
Note : CE2s and $\overline{WE}$ must be High during the entire read cycle.

• READ Timing #2 ($\overline{CE1}$s Control Access) (FCRAM)



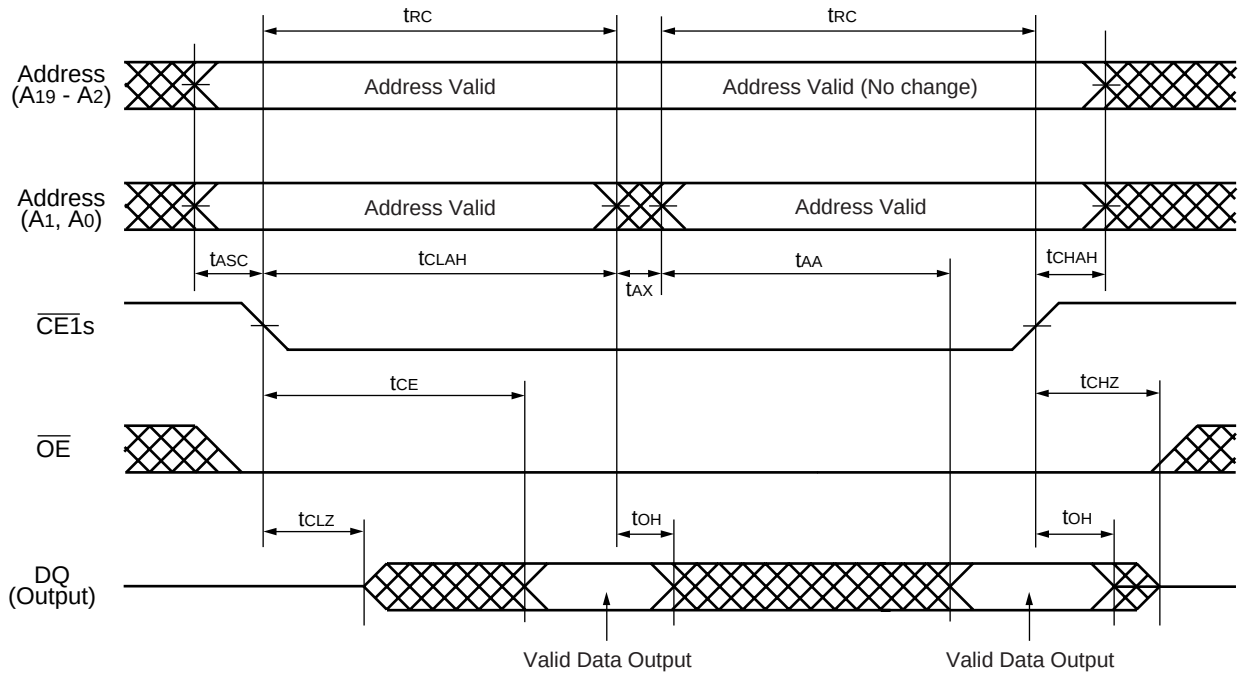
Note : CE2s and $\overline{WE}$ must be High during the entire read cycle.

• READ Timing #3 (Address Access after $\overline{OE}$ Control Access) (FCRAM)



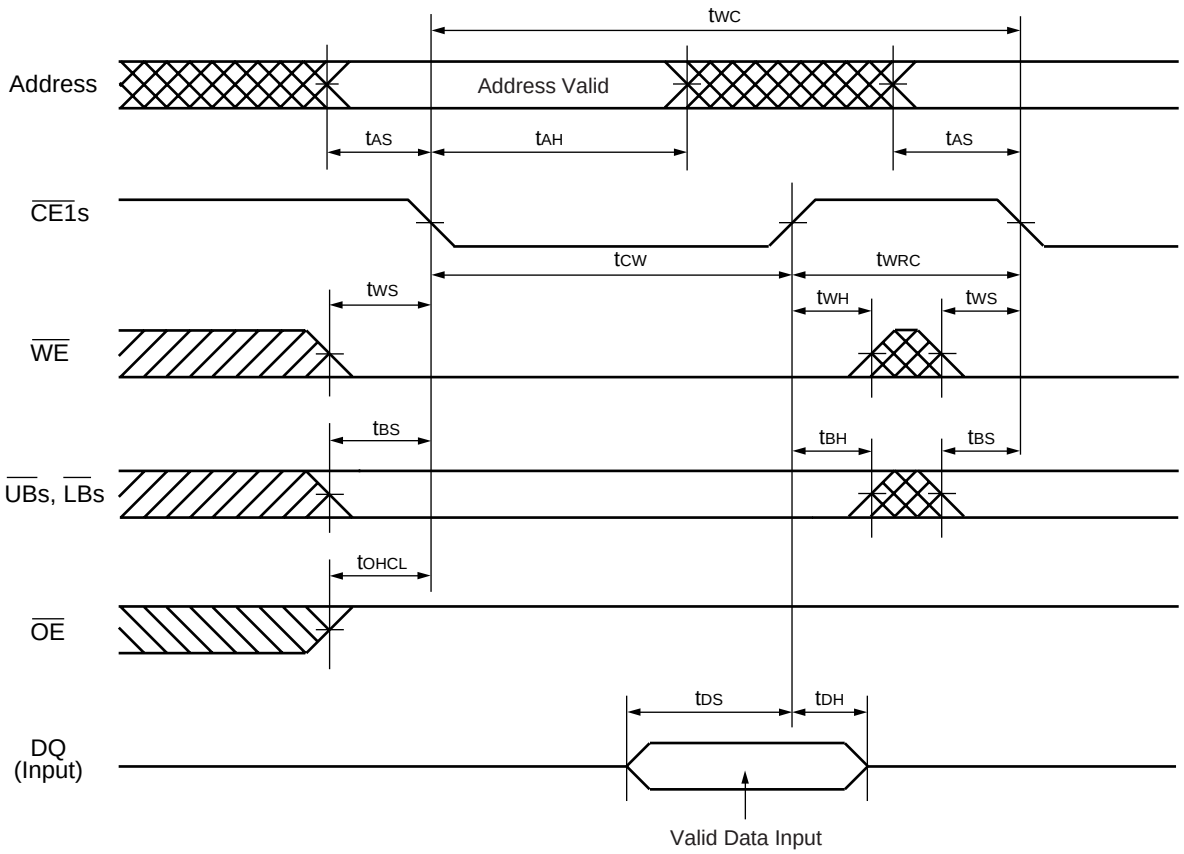
Note : CE2s and $\overline{WE}$ must be High during the entire read cycle.

• READ Timing #4 (Address Access after $\overline{CE1}$s Control Access) (FCRAM)



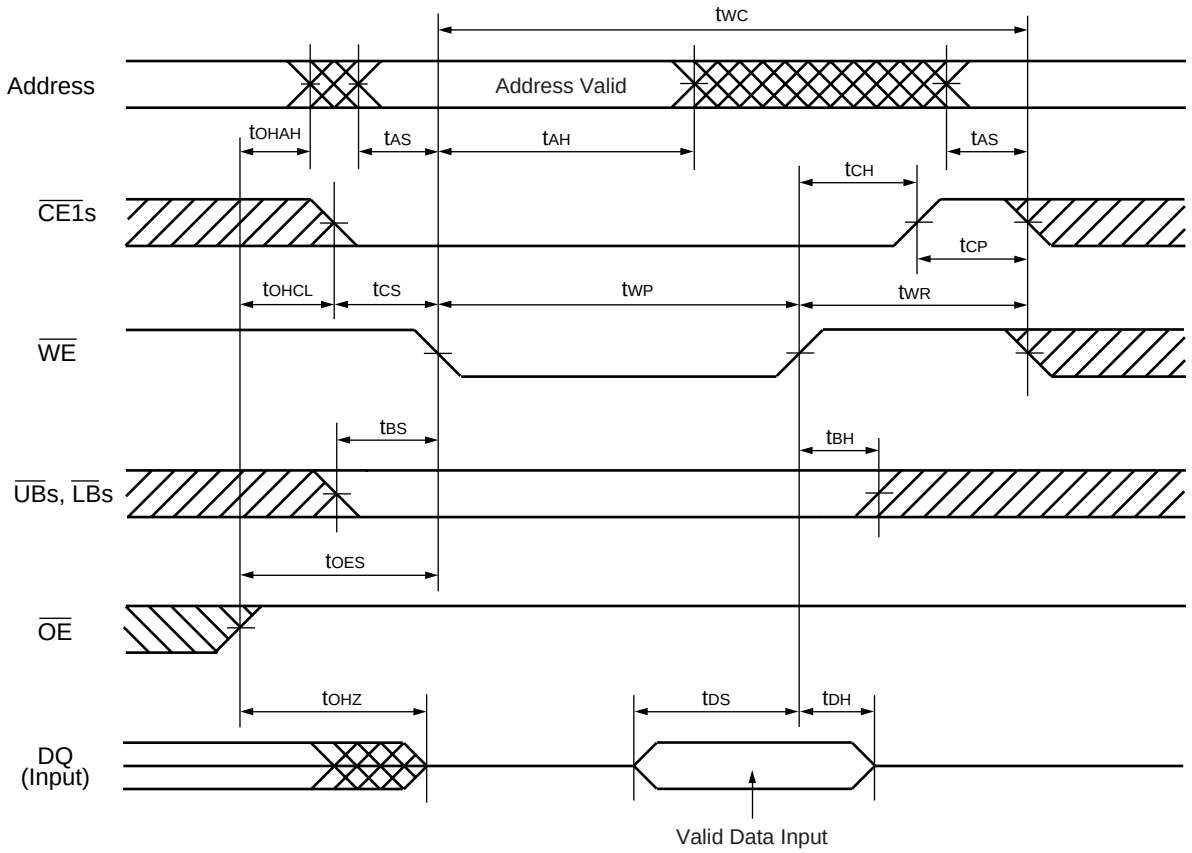
Note : CE2s and $\overline{WE}$ must be High during the entire read cycle.

● **WRITE Timing #1 ($\overline{CE1}$s Control) (FCRAM)**



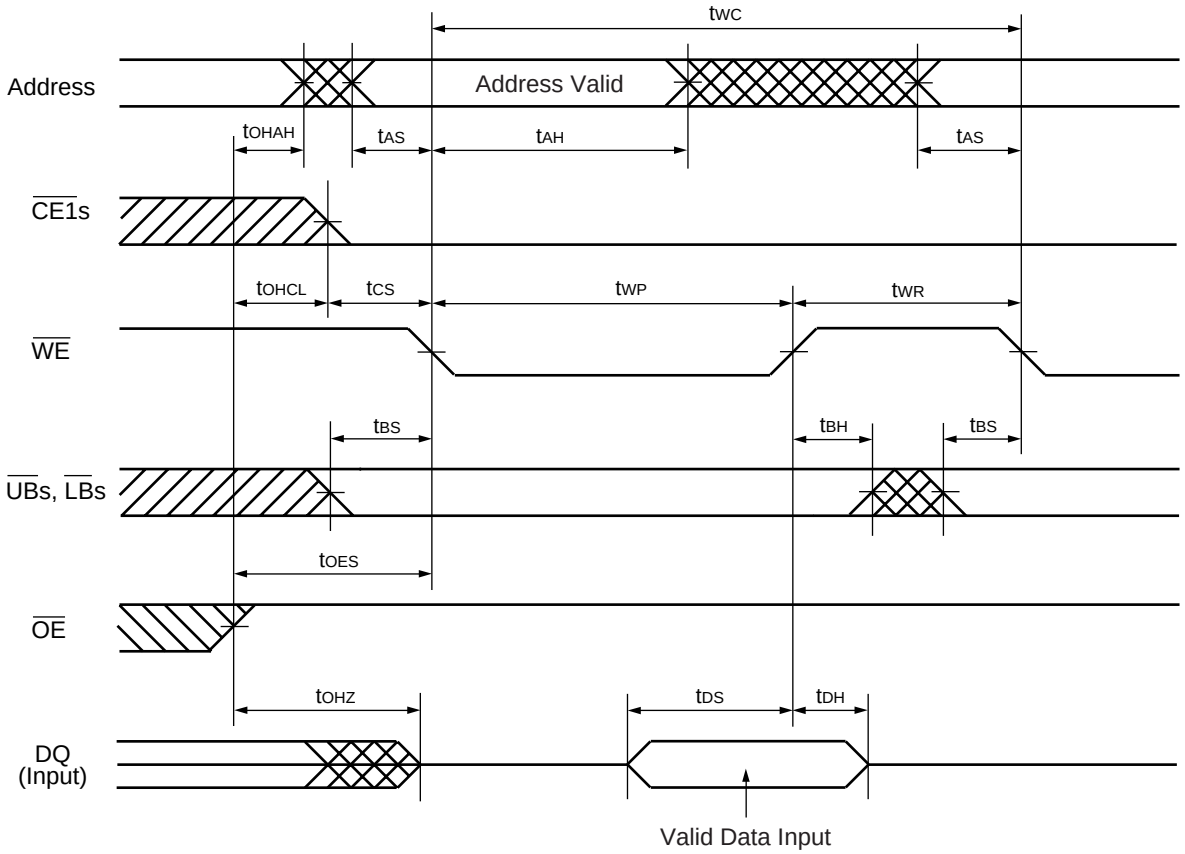
Note : CE2s must be High during the write cycle.

● **WRITE Timing #2-1 ($\overline{WE}$ Control, Single Write Operetion) (FCRAM)**



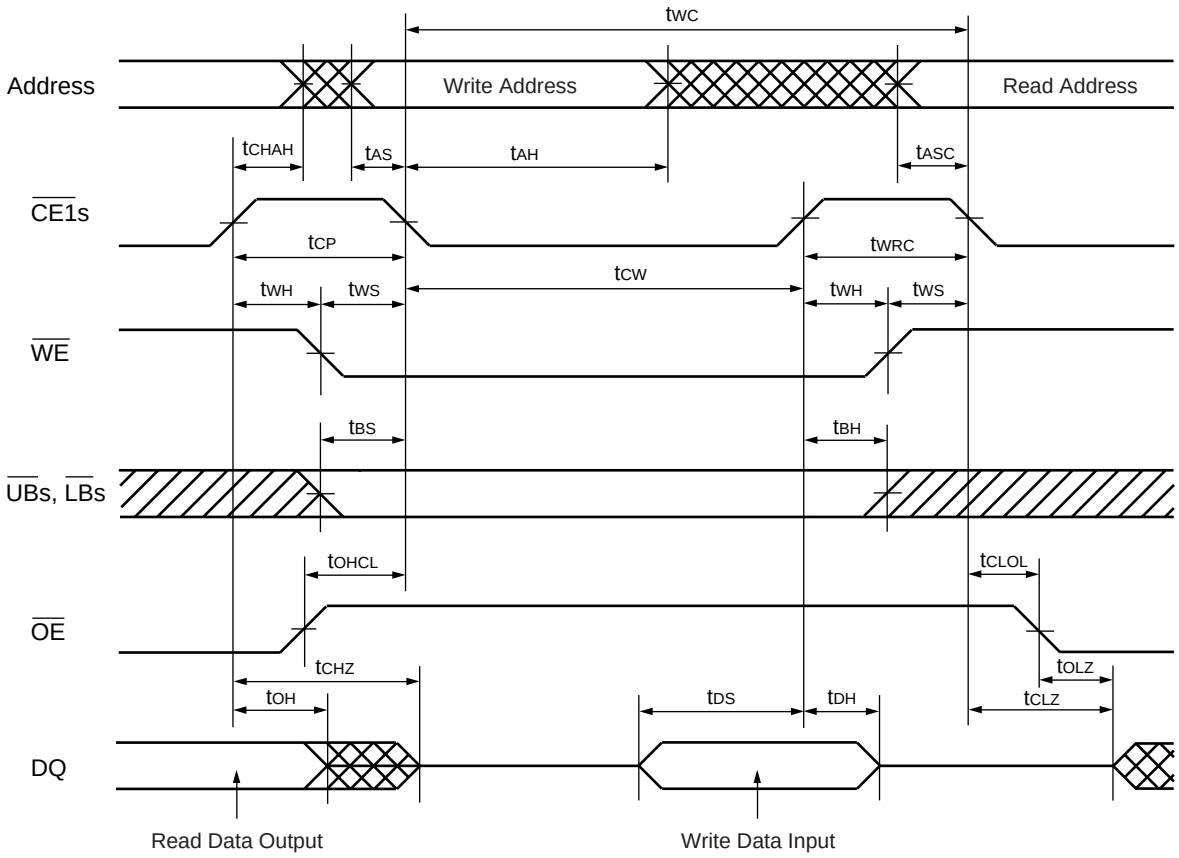
Note : CE2s must be High during the write cycle.

● **WRITE Timing #2 ($\overline{WE}$ Control, Continuous Write Operetion) (FCRAM)**



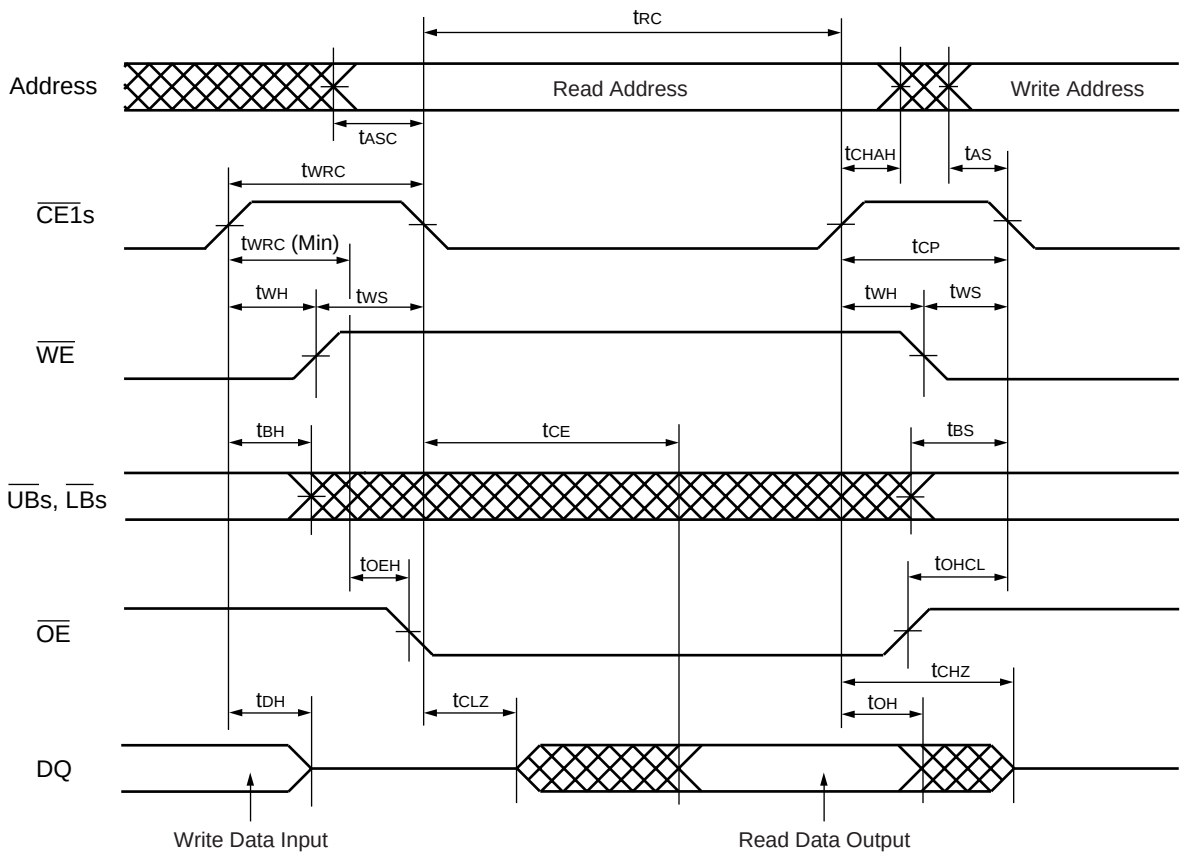
Note : CE2s must be High during the write cycle.

● **READ/WRITE Timing #1-1 ($\overline{CE1}$s Control) (FCRAM)**



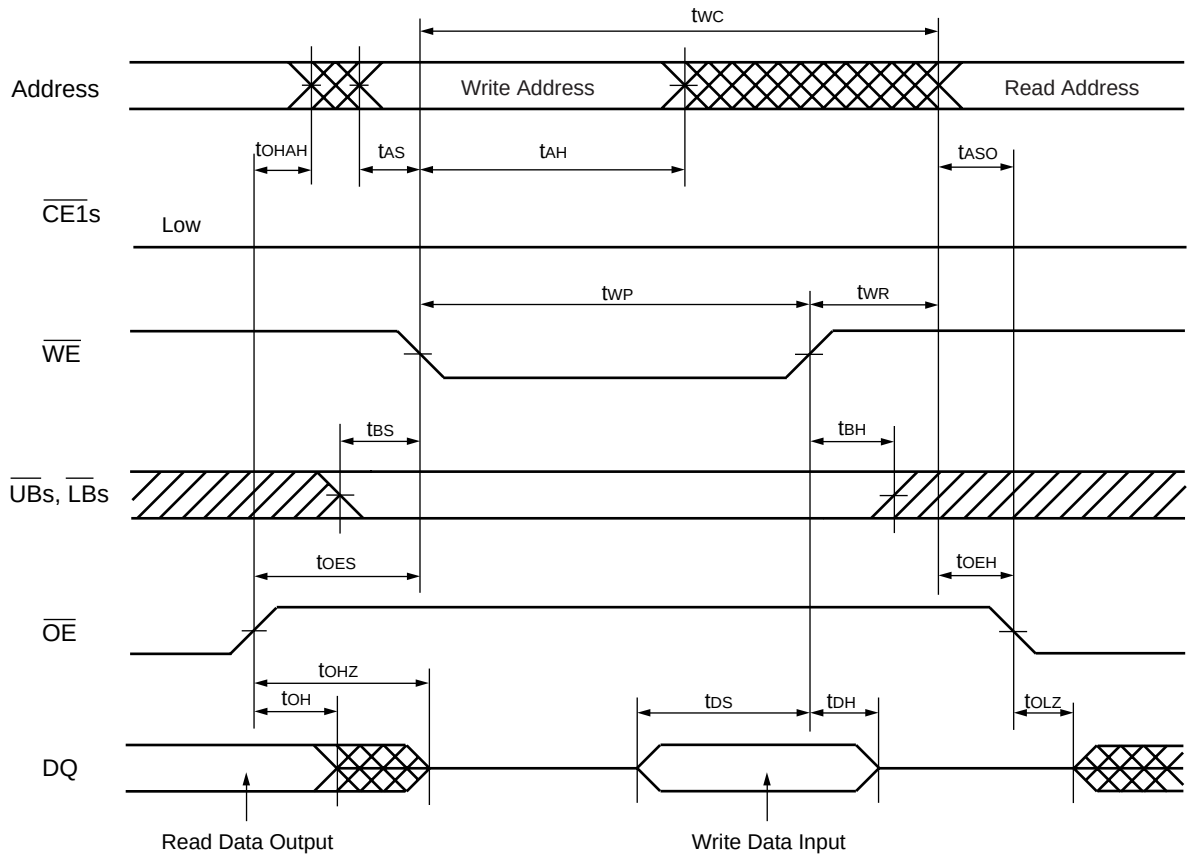
Note : Write address is vaild from either $\overline{CE1}$s or $\overline{WE}$ of the last falling edge.

● **READ/WRITE Timing #1-2 ($\overline{CE1}$s Control) (FCRAM)**



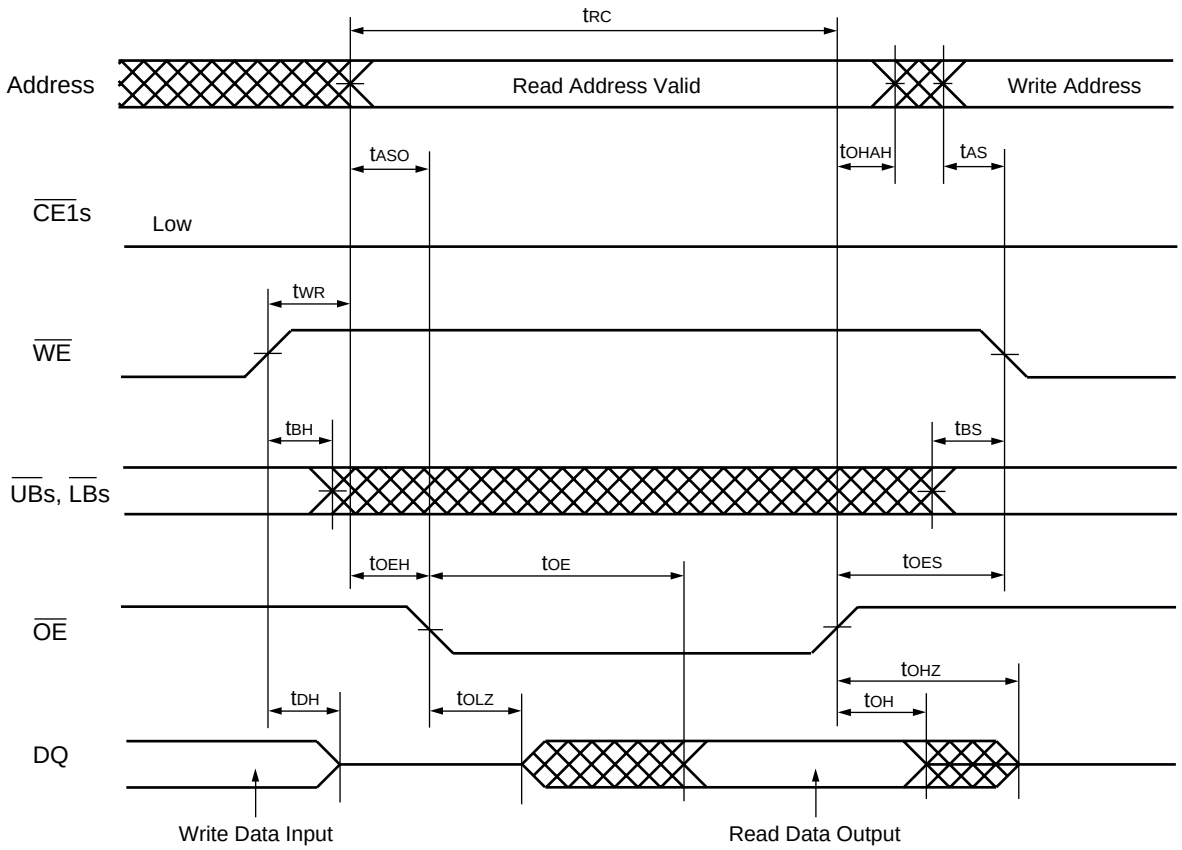
Note : t_{OEH} is specified from the time satisfied both t_{WRC} and t_{WR} (Min) .

● **READ ($\overline{OE}$ Control) /WRITE ($\overline{WE}$ Control) Timing #2-1 (FCRAM)**



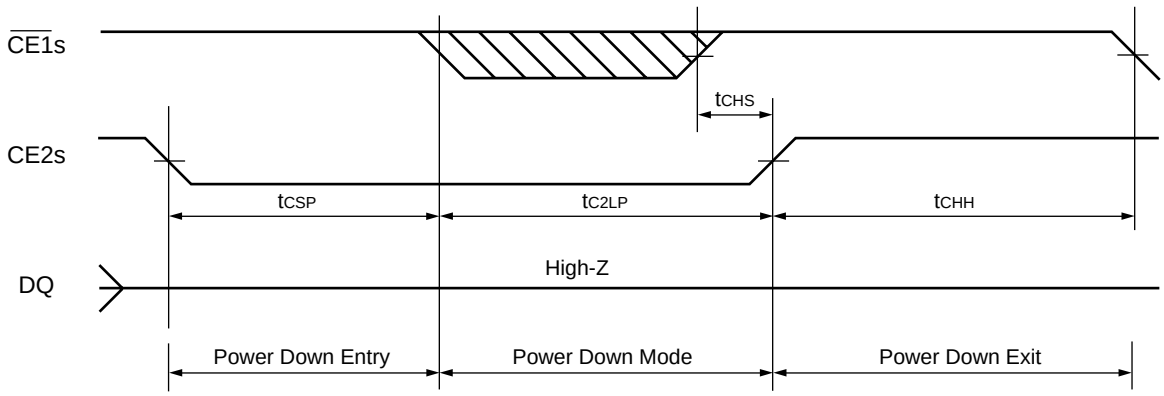
Note : $\overline{CE1}$s can be tied to Low for $\overline{WE}$ and $\overline{OE}$ controlled operation.
When $\overline{CE1}$s is tied to Low, output is exclusively controlled by $\overline{OE}$.

● **READ ($\overline{OE}$ Control) / WRITE ($\overline{WE}$ Control) Timing #2-2**

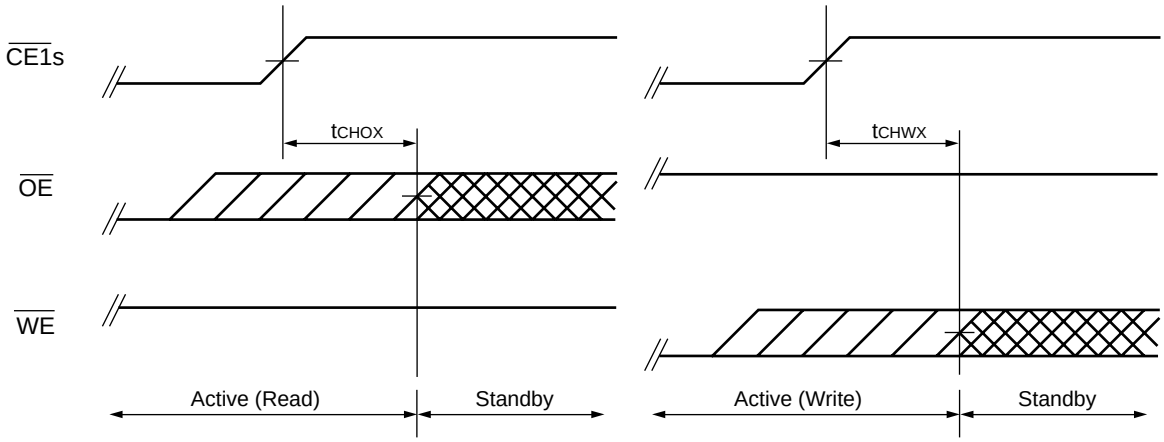


Note : $\overline{CE1}$s can be tied to Low for $\overline{WE}$ and $\overline{OE}$ controlled operation.
When $\overline{CE1}$s is tied to Low, output is exclusively controlled by $\overline{OE}$.

● **POWER DOWN Timing (FCRAM)**

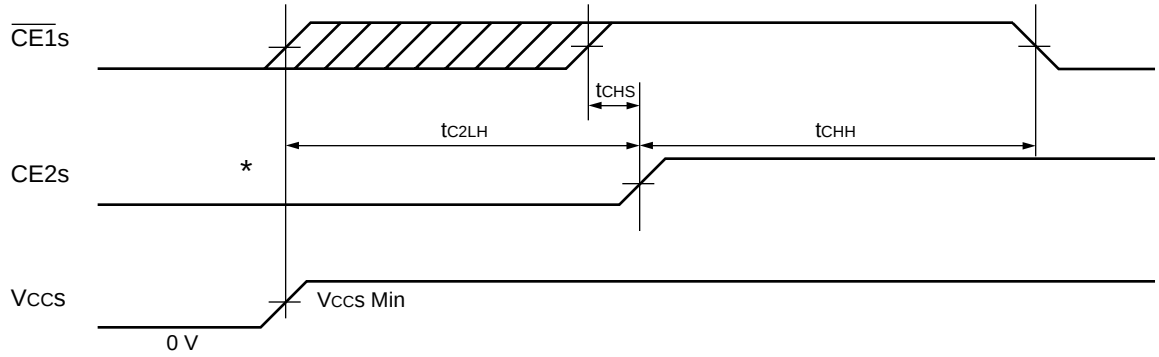


● **Standby Entry Timing after Read or Write (FCRAM)**



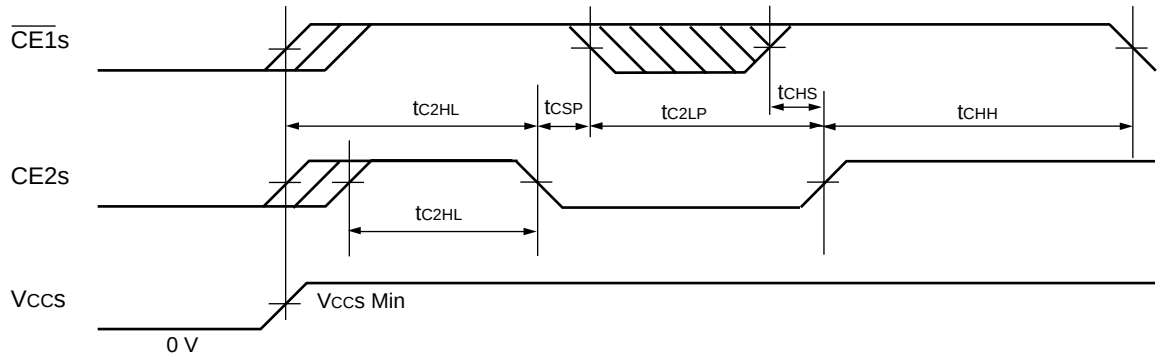
Note : Both t_{CHOX} and t_{CHWX} define the earliest entry timing for Standby mode. If either of timing is not satisfied, it takes t_{RC} (Min) period from either last address transition of A0 and A1, or $\overline{CE1}$s Low to High transition.

● **POWER-UP Timing 1 (FCRAM)**



* : It is recommended to keep CE2s at Low during V_{CC}s power-up.
t_{C2LH} specifies after V_{CC}s reaches specified minimum level.

● **POWER-UP Timing 2 (FCRAM)**



Note : t_{C2LH} specifies from CE2s Low to High transition after V_{CCS} reaches specified minimum level.
$\overline{CE1}$s must be brought to High prior to or together with CE2s Low to High transition.

■ ERASE AND PROGRAMMING PERFORMANCE (Flash)

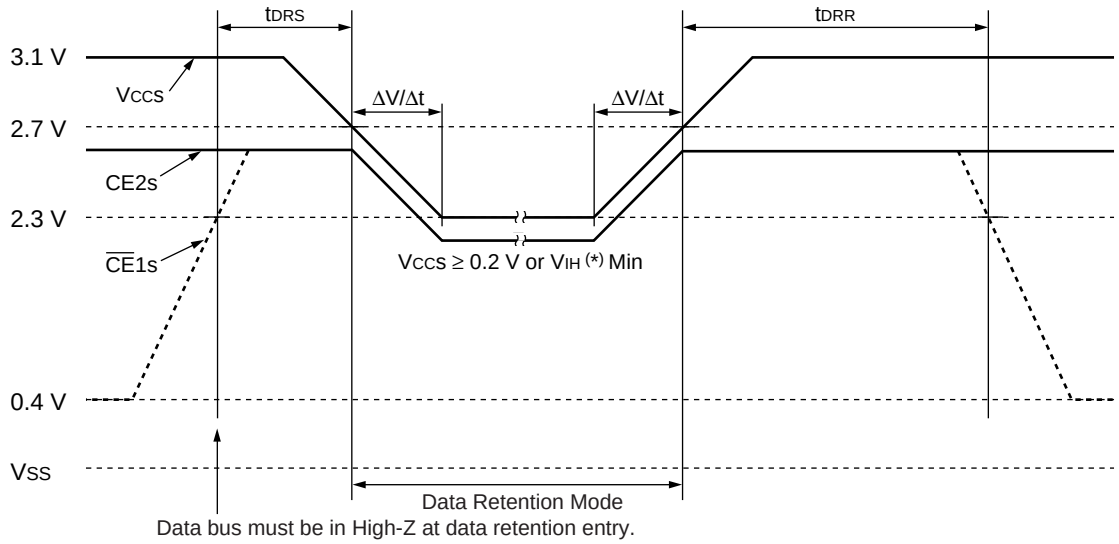
Parameter	Value			Unit	Remarks
	Min	Typ	Max		
Sector Erase Time	—	1	10	s	Excludes programming time prior to erasure
Word Programming Time	—	16	360	µs	Excludes system-level overhead
Chip Programming Time	—	—	200	s	Excludes system-level overhead
Erase/Program Cycle	100,000	—	—	cycle	

■ DATA RETENTION CHARACTERISTICS (FCRAM)

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
V_{CCS} Data Retention Supply Voltage	V_{DR}	$\overline{CE1}s = CE2s \geq V_{CCS} - 0.2$ V or, $\overline{CE1}s = CE2s = V_{IH}$	2.3	—	3.1	V
V_{CCS} Data Retention Supply Current	I_{DR}	2.3 V ≤ V_{CCS} ≤ 2.7 V, $V_{IN} = V_{IH}$* or V_{IL} $\overline{CE1}s = CE2s = V_{IH}$*, I_{OUT}=0 mA	—	0.5	1	mA
	I_{DR1}	2.3 V ≤ V_{CCS} ≤ 2.7 V, $V_{IN} \leq 0.2$ V or $V_{IN} \geq V_{CCS} - 0.2$ V, $\overline{CE1}s = CE2s \geq V_{CCS} - 0.2$ V, I_{OUT}=0 mA	—	—	70	µA
Data Retention Setup Time	t_{DRS}	2.7 V ≤ V_{CCS} ≤ 3.1 V at data retention entry	0	—	—	ns
Data Retention Recovery Time	t_{DRR}	2.7 V ≤ V_{CCS} ≤ 3.1 V after data retention	90	—	—	ns
V_{CCS} Voltage Transition Time	$\Delta V/\Delta t$	—	0.5	—	—	V/µs

*: 2.0 V ≤ V_{IH} ≤ V_{CCS} + 0.3 V

• **Data Retention Timing**



* : 2.0 V ≤ V_{IH} ≤ V_{CCS} + 3 V

■ PIN CAPACITANCE

Parameter	Symbol	Condition	Value		Unit
			Typ	Max	
Input Capacitance	C_{IN}	V_{IN} = 0 V	11	14	pF
Output Capacitance	C_{OUT}	V_{OUT} = 0 V	12	16	pF
Control Pin Capacitance	C_{IN2}	V_{IN} = 0 V	14	16	pF
$\overline{WP}$/ACC Pin Capacitance	C_{IN3}	V_{IN} = 0 V	21.5	26	pF

Note: Test conditions T_A = +25°C, f = 1.0 MHz

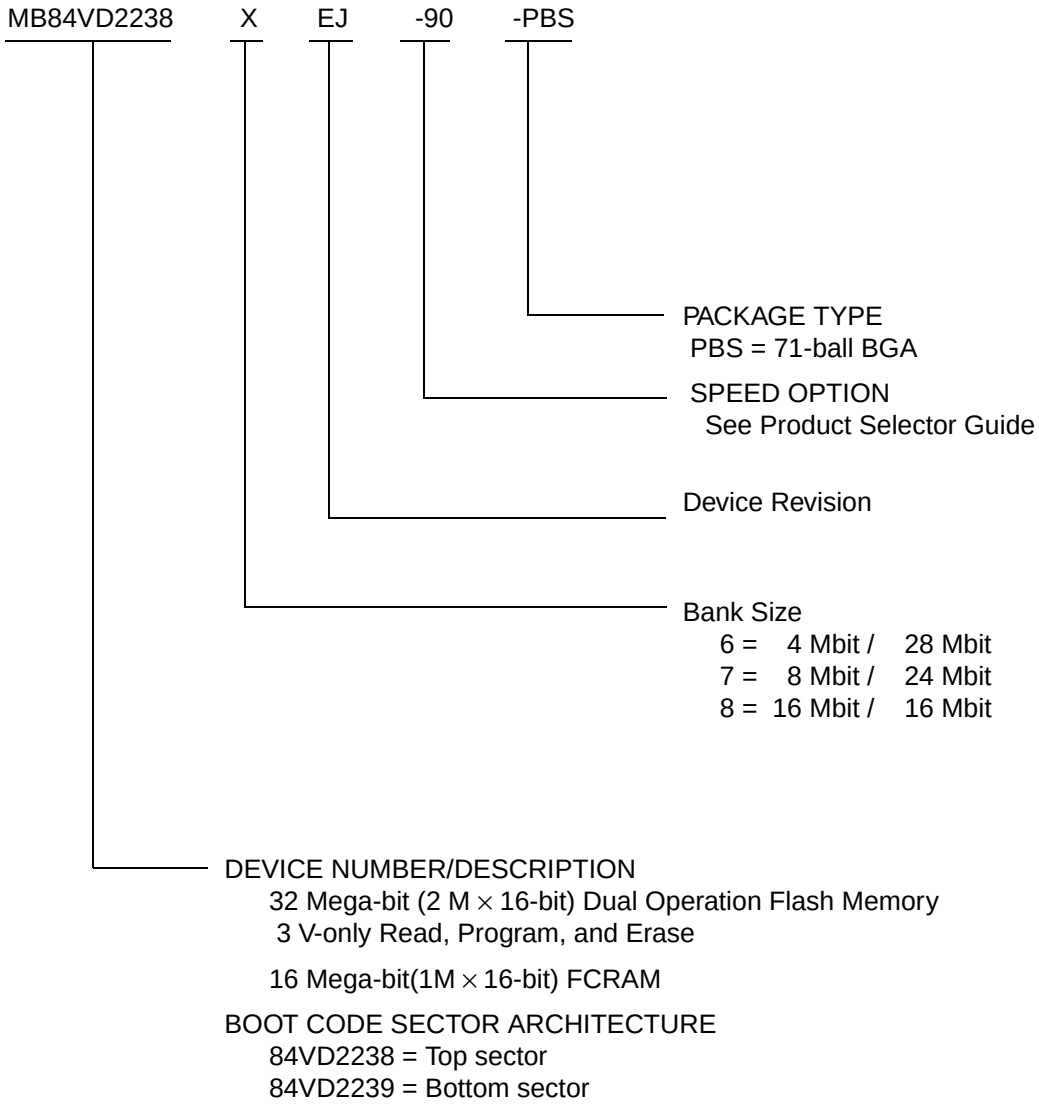
■ HANDLING OF PACKAGE

Please handle this package carefully since the sides of package are created acute angles.

■ CAUTION

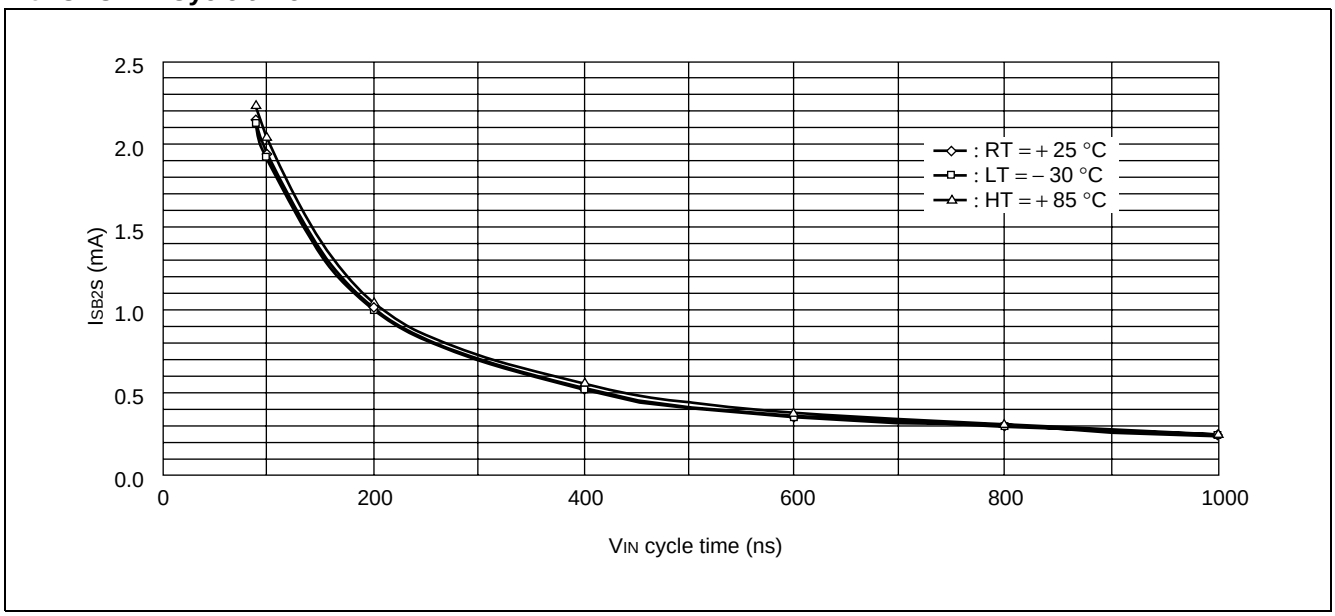
- The high voltage (V_{ID}) cannot apply to address pins and control pins except $\overline{RESET}$.
  Exception is when autoselect and sector protect function are used. Then the high voltage (V_{ID}) can be applied to $\overline{RESET}$.
- Without the high voltage (V_{ID}) , sector protection can be achieved by using “Extended Sector Group Protection” command.

■ ORDERING INFORMATION



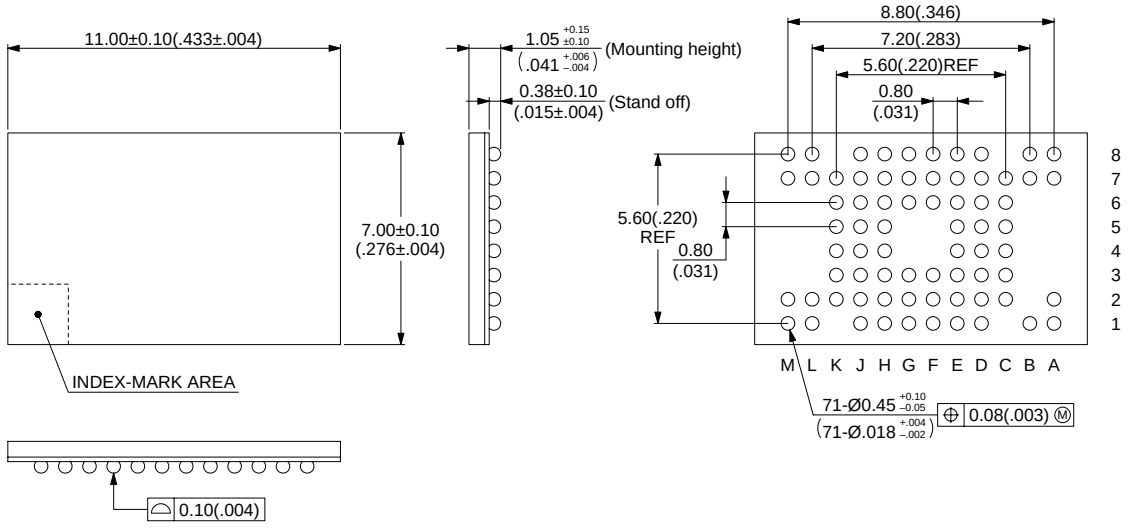
■ APPENDIX

● I_{SB2S} vs. V_{IN} Cycle time



■ PACKAGE DIMENSION

71-pin plastic FBGA
(BGA-71P-M02)



Dimensions in mm (inches).

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